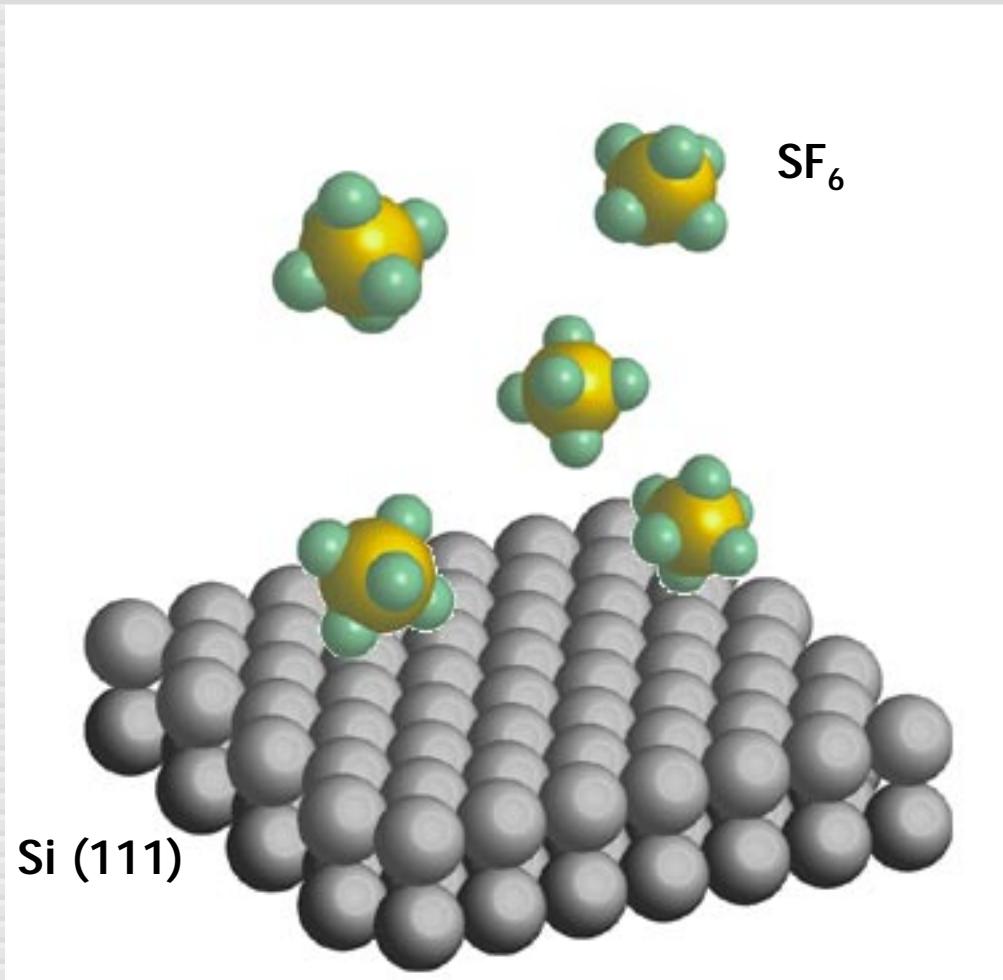


# **Fabrication of micrometer-sized conical field emitters using femtosecond laser-assisted etching of silicon**

**Jim Carey  
Eric Mazur  
Catherine Crouch  
Rebecca Younkin**

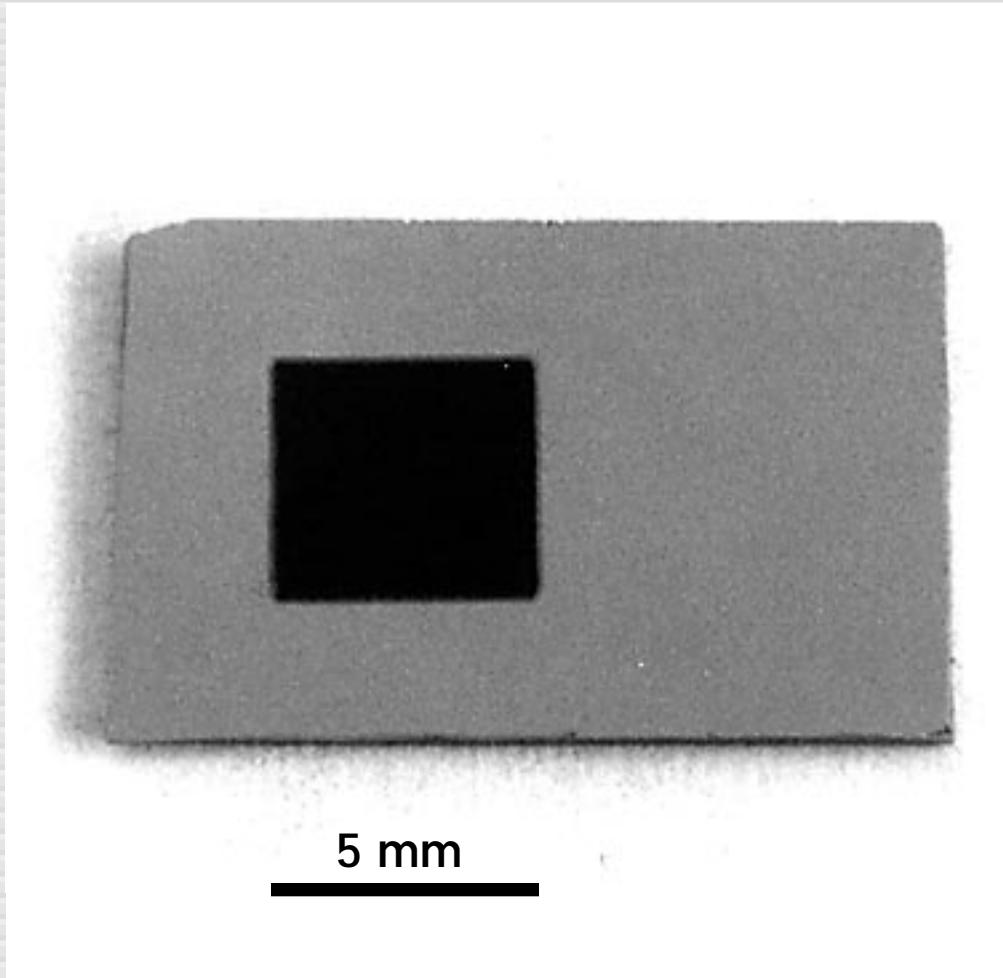


# *Introduction*



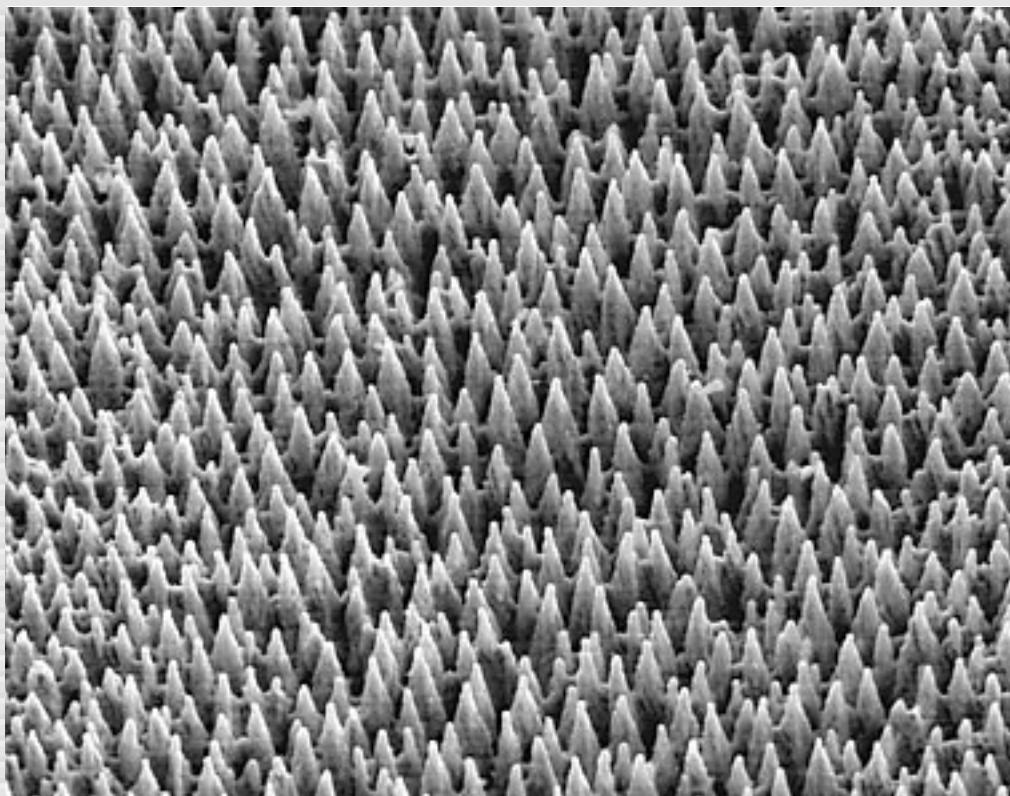
irradiate with 100-fs  $10 \text{ kJ/m}^2$  pulses

# *Introduction*



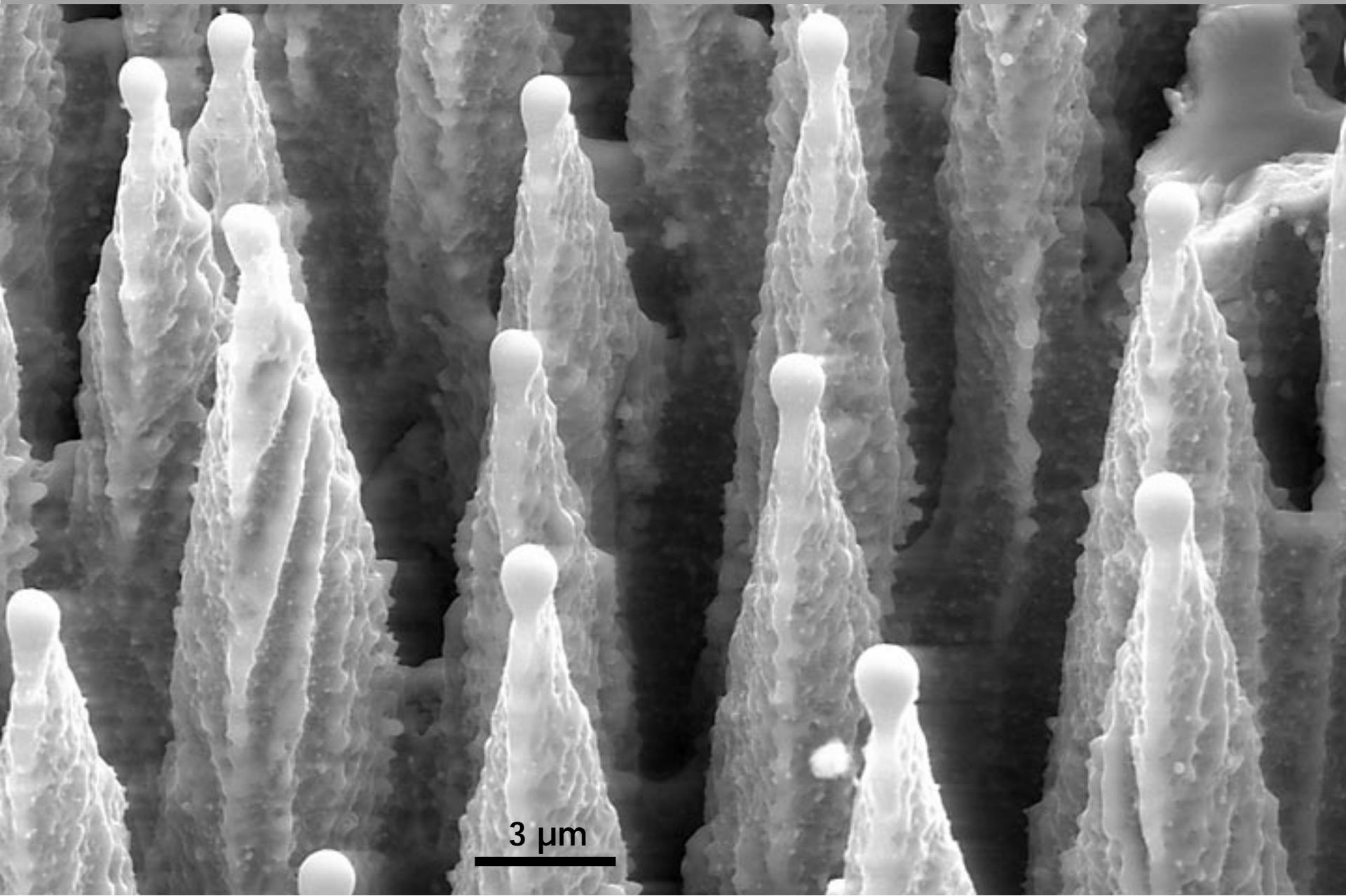
**"black silicon"**

# *Introduction*

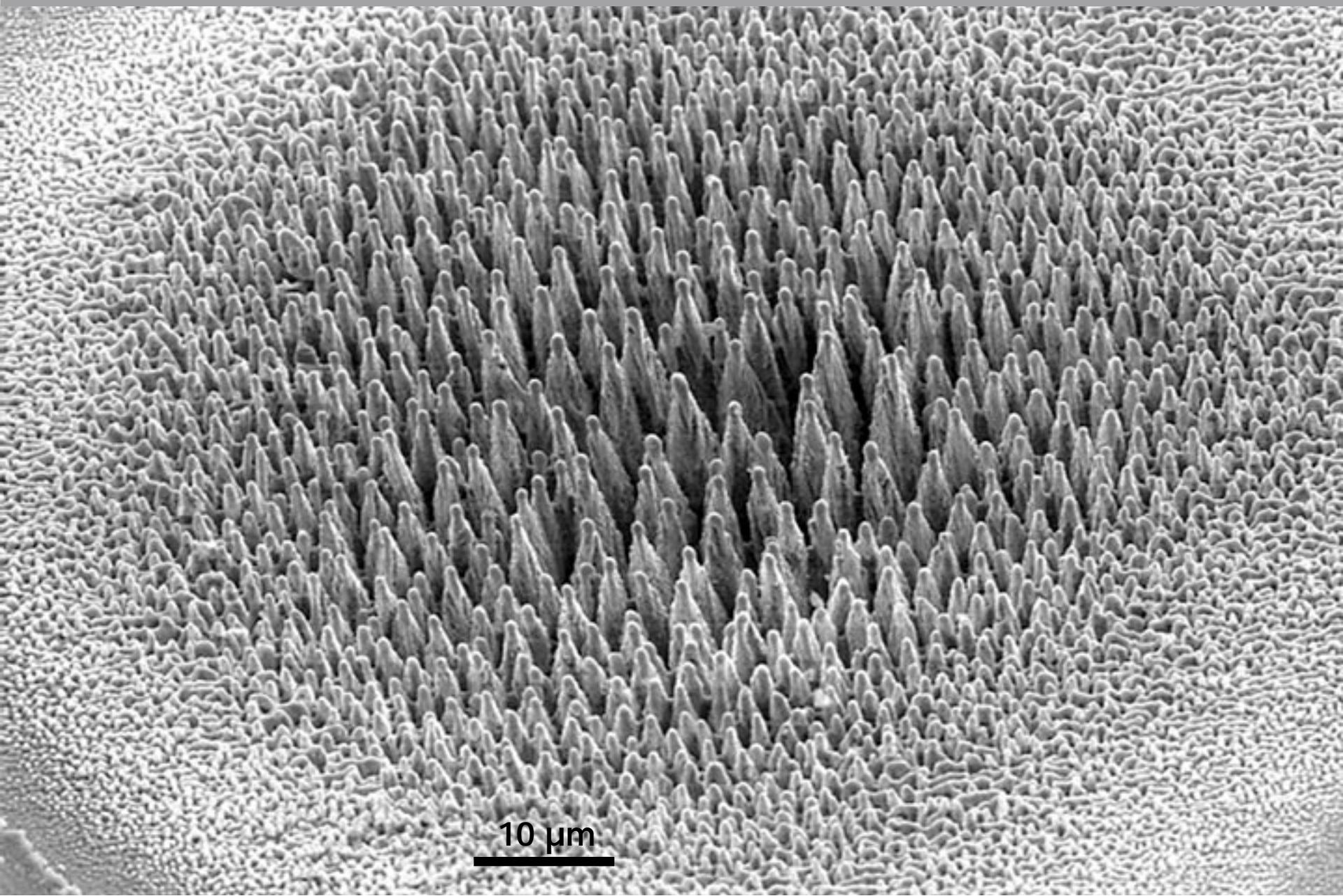


20  $\mu\text{m}$

## *Introduction*



## *Introduction*



# *Outline*

- ▶ **Background**
- ▶ **Results**
- ▶ **Discussion**

x2000

#3548

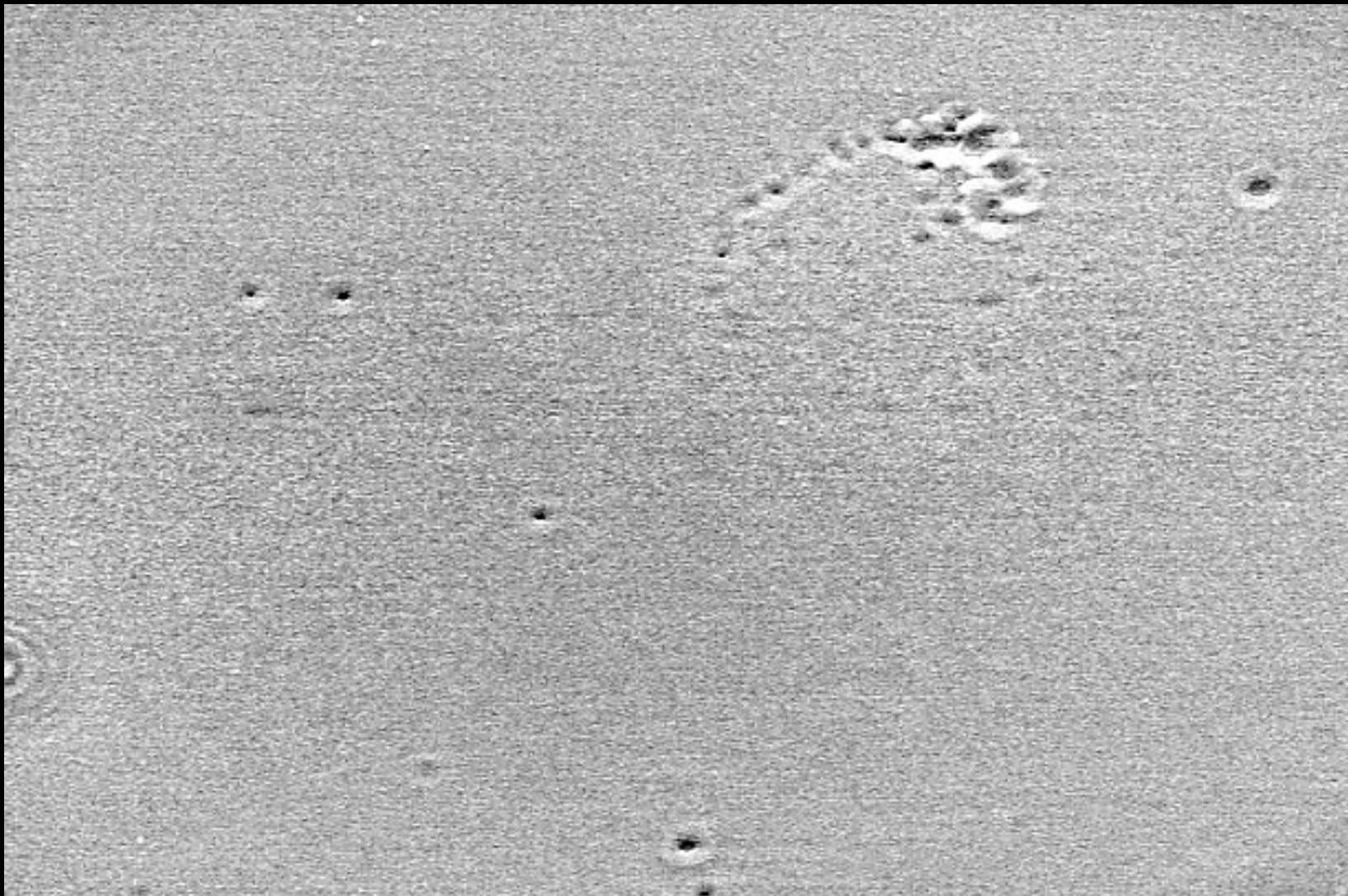
512 x 480

20  $\mu$ m

10kV

15mm

0000



x2000

#3548

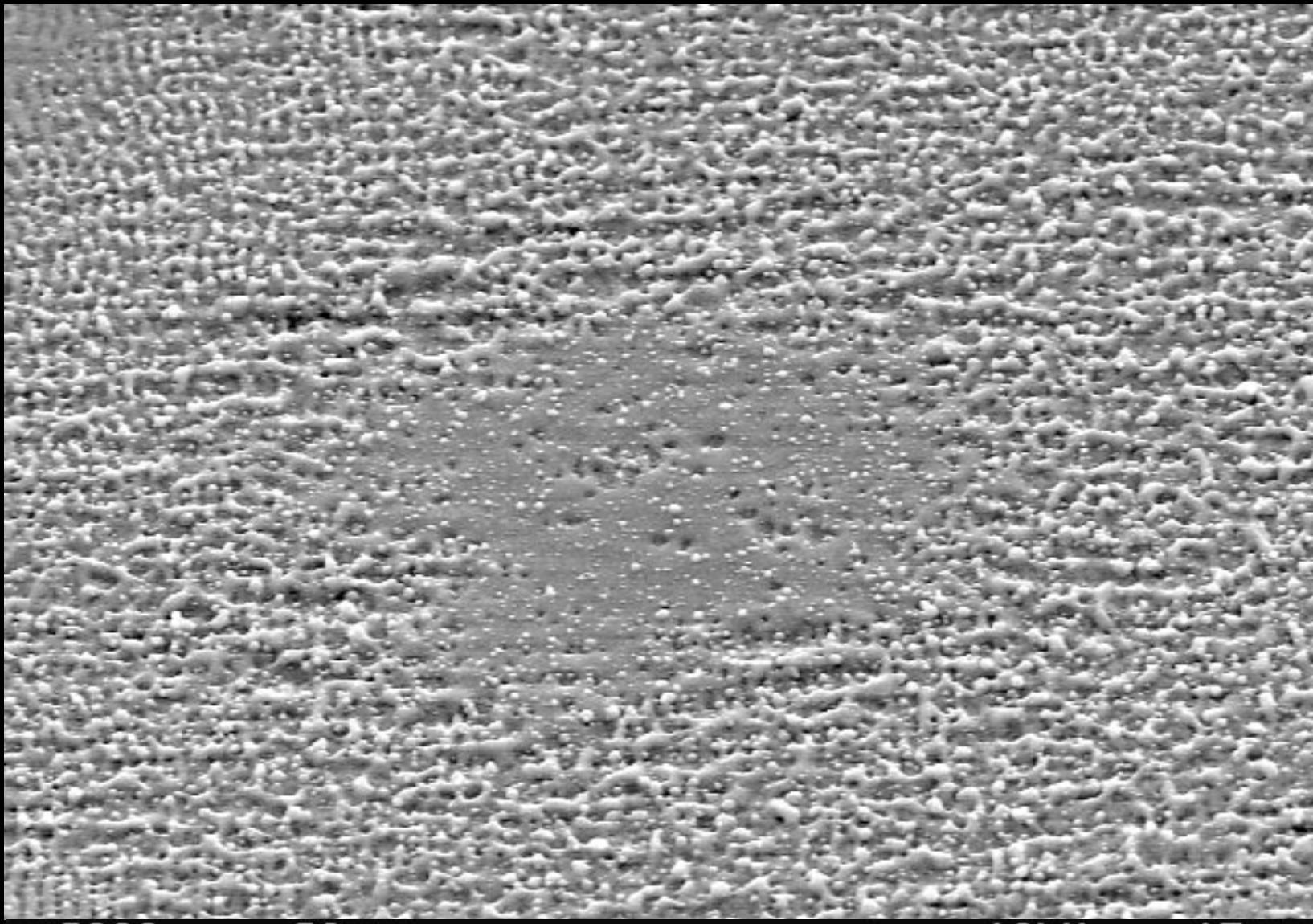
512 x 480

20 μm

10kV

15mm

0001



x2000

#3548

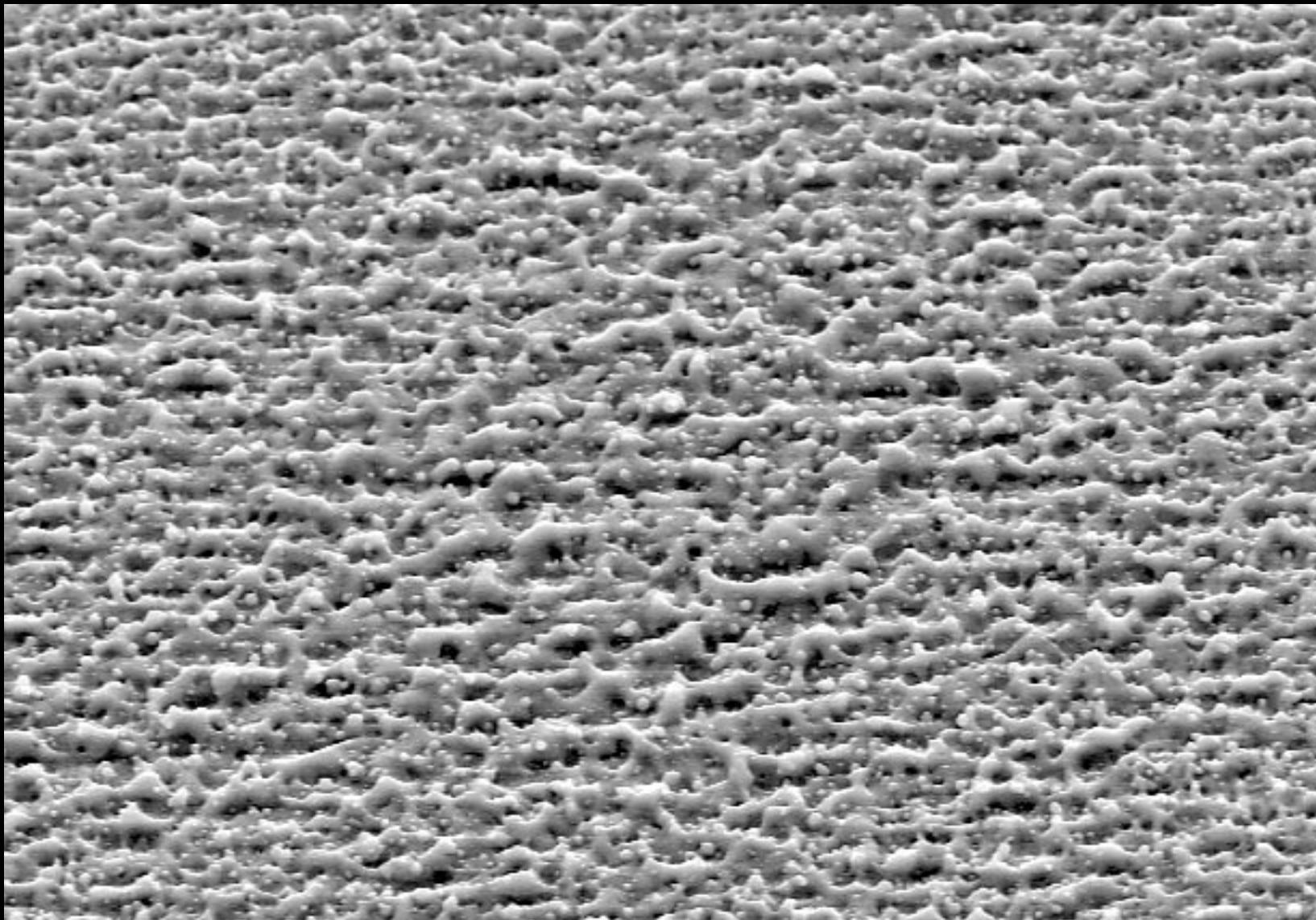
512 x 480

20  $\mu\text{m}$

10kV

15mm

0005



x2000

#3548

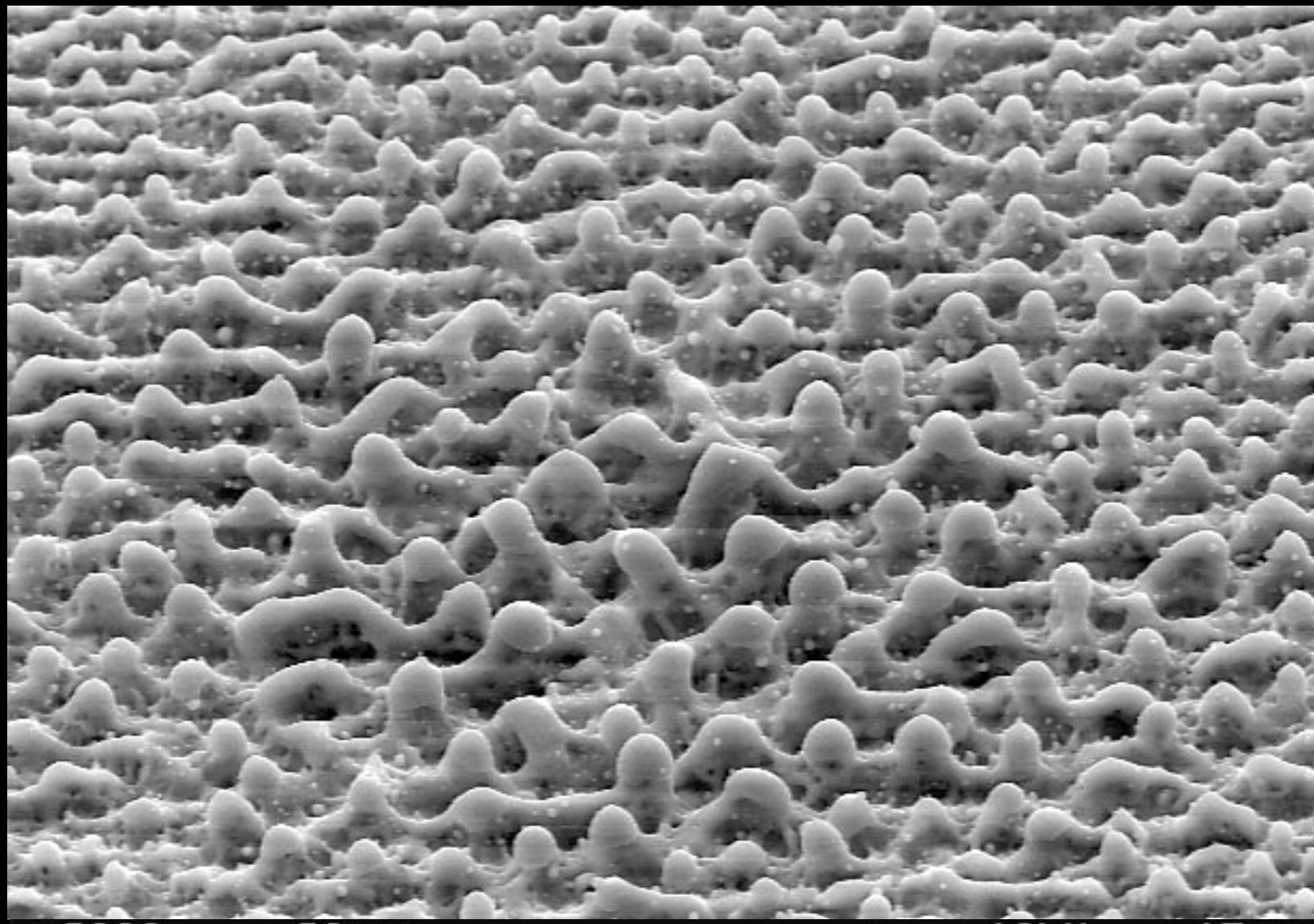
512 x 480

20 μm

10kV

15mm

0010



x2000

#3548

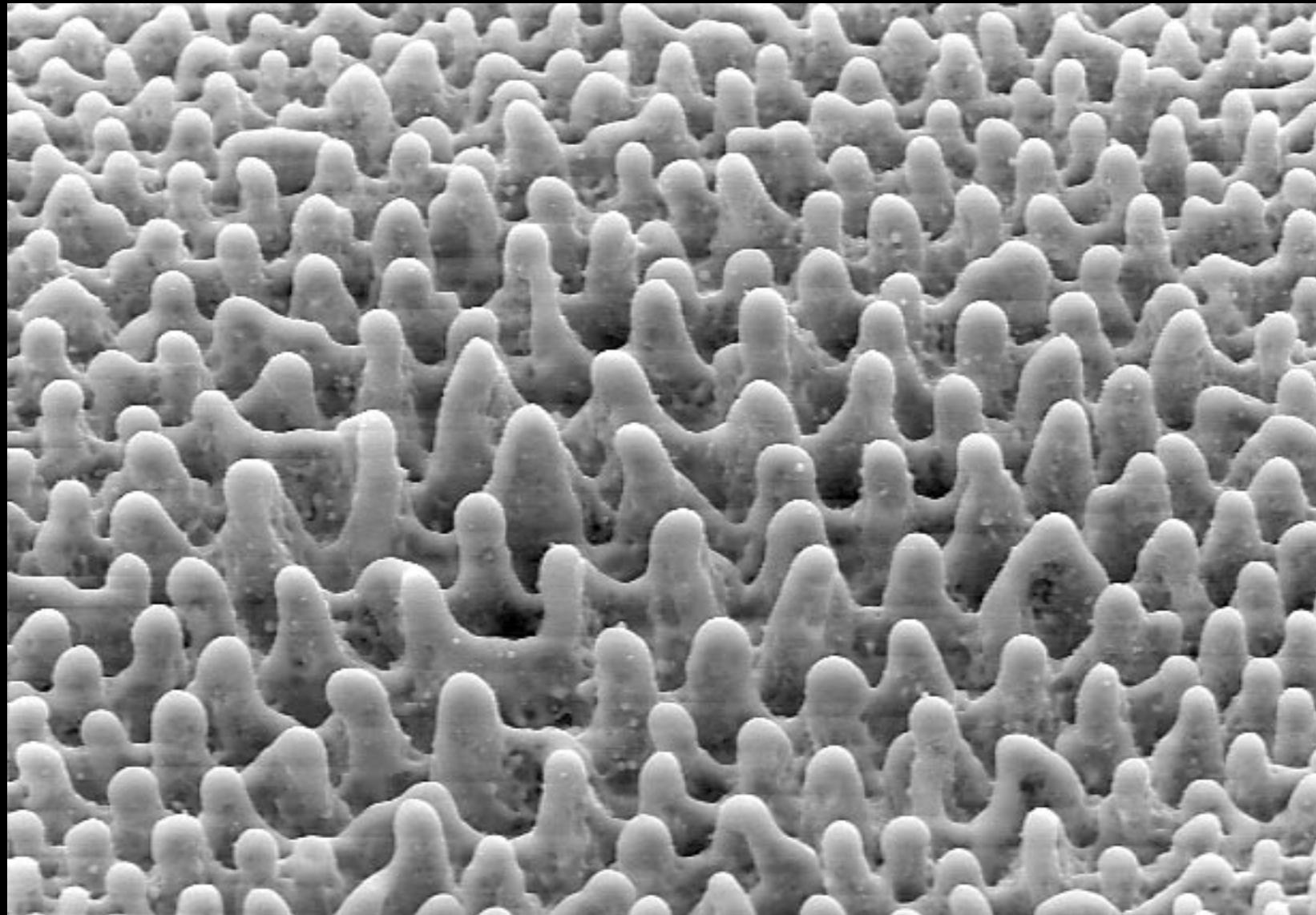
512 x 480

20 μm

10kV

15mm

0025



x2000

20  $\mu\text{m}$

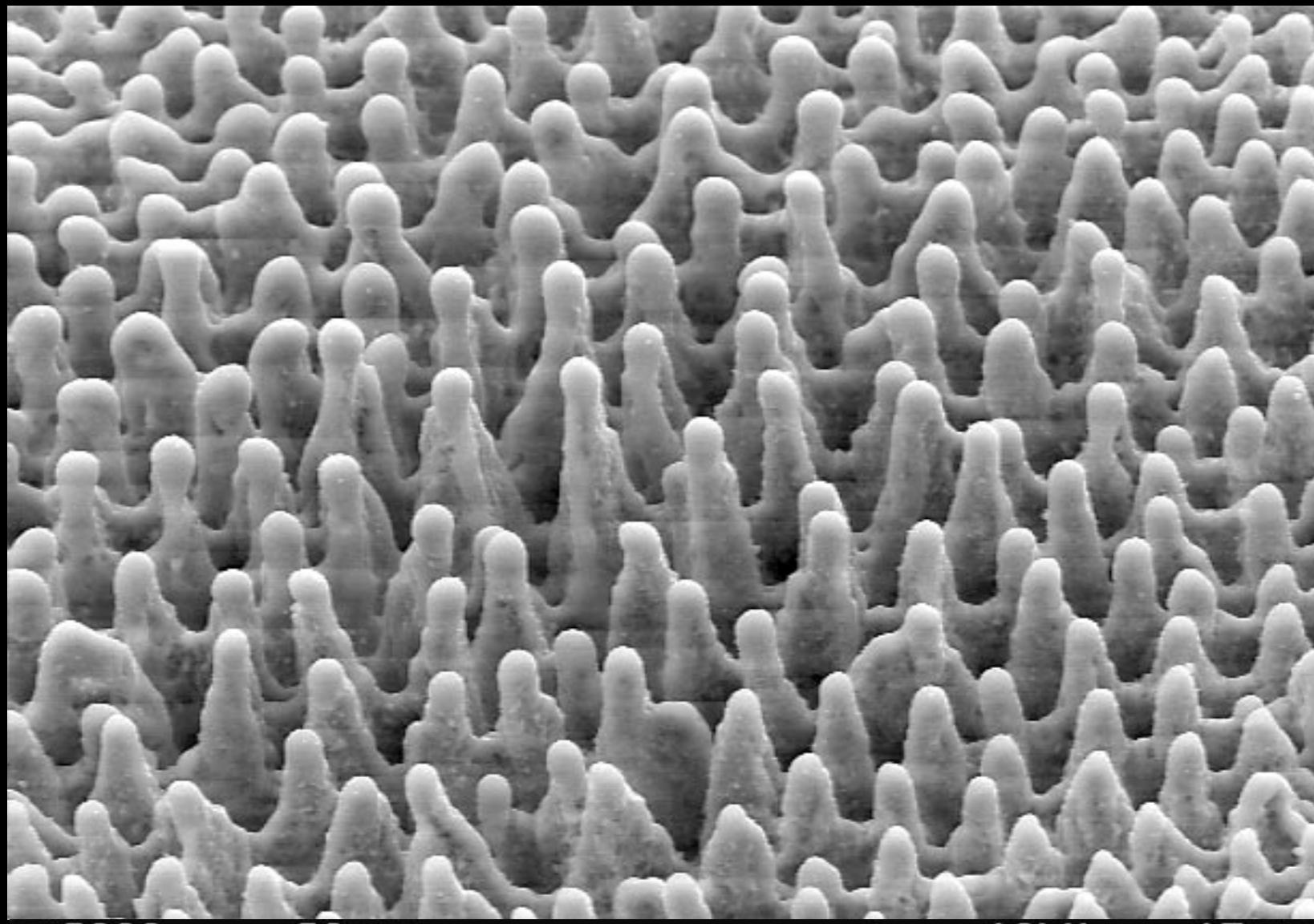
10kV

15mm

#3548

512 x 480

0050



x2000

20  $\mu\text{m}$

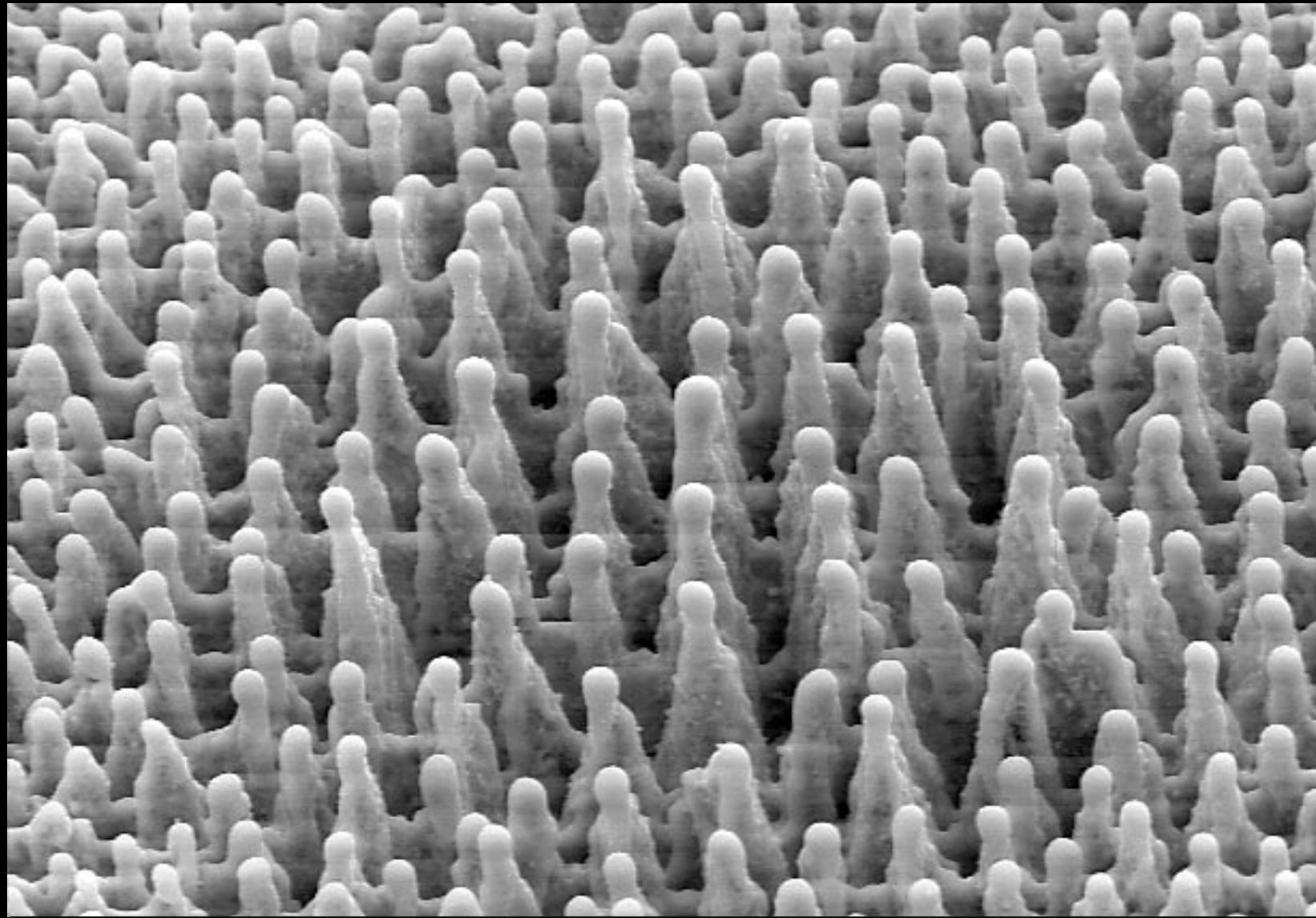
10kV

15mm

#3548

512 x 480

0075



x2000

20  $\mu\text{m}$

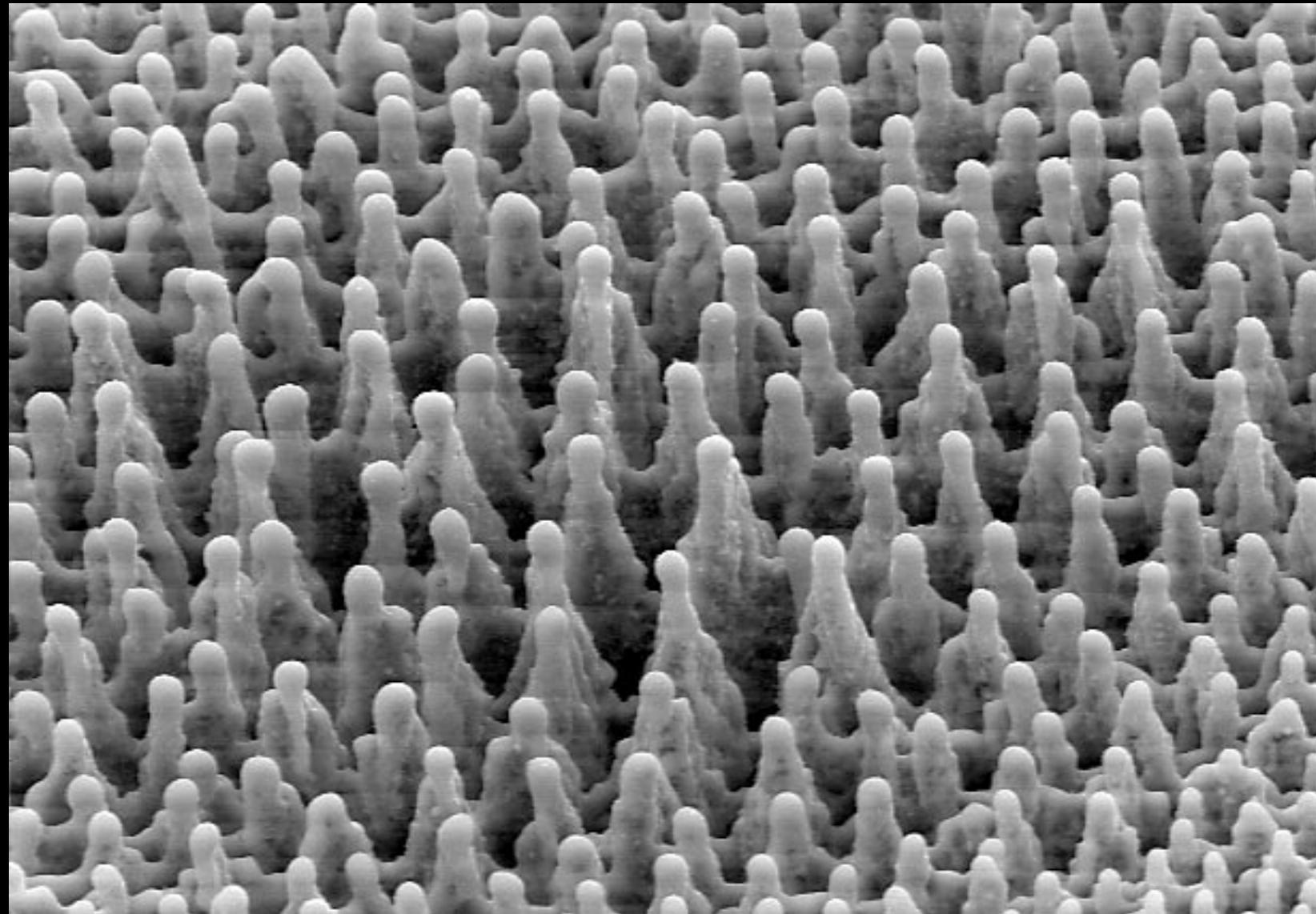
10kV

15mm

#3548

512 x 480

0100



x2000

#3548

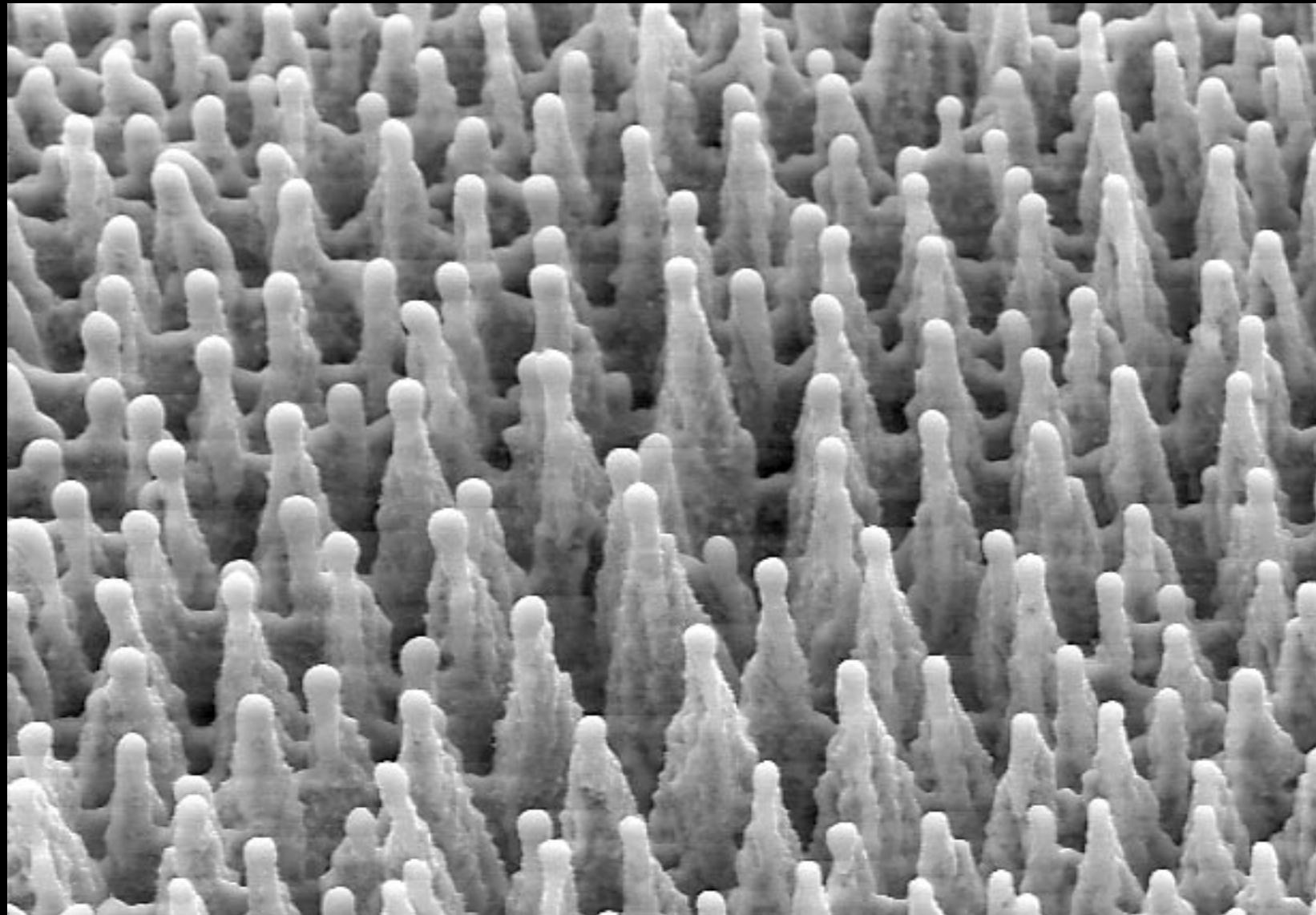
512 x 480

20 μm

10kV

15mm

0125



x2000

#3548

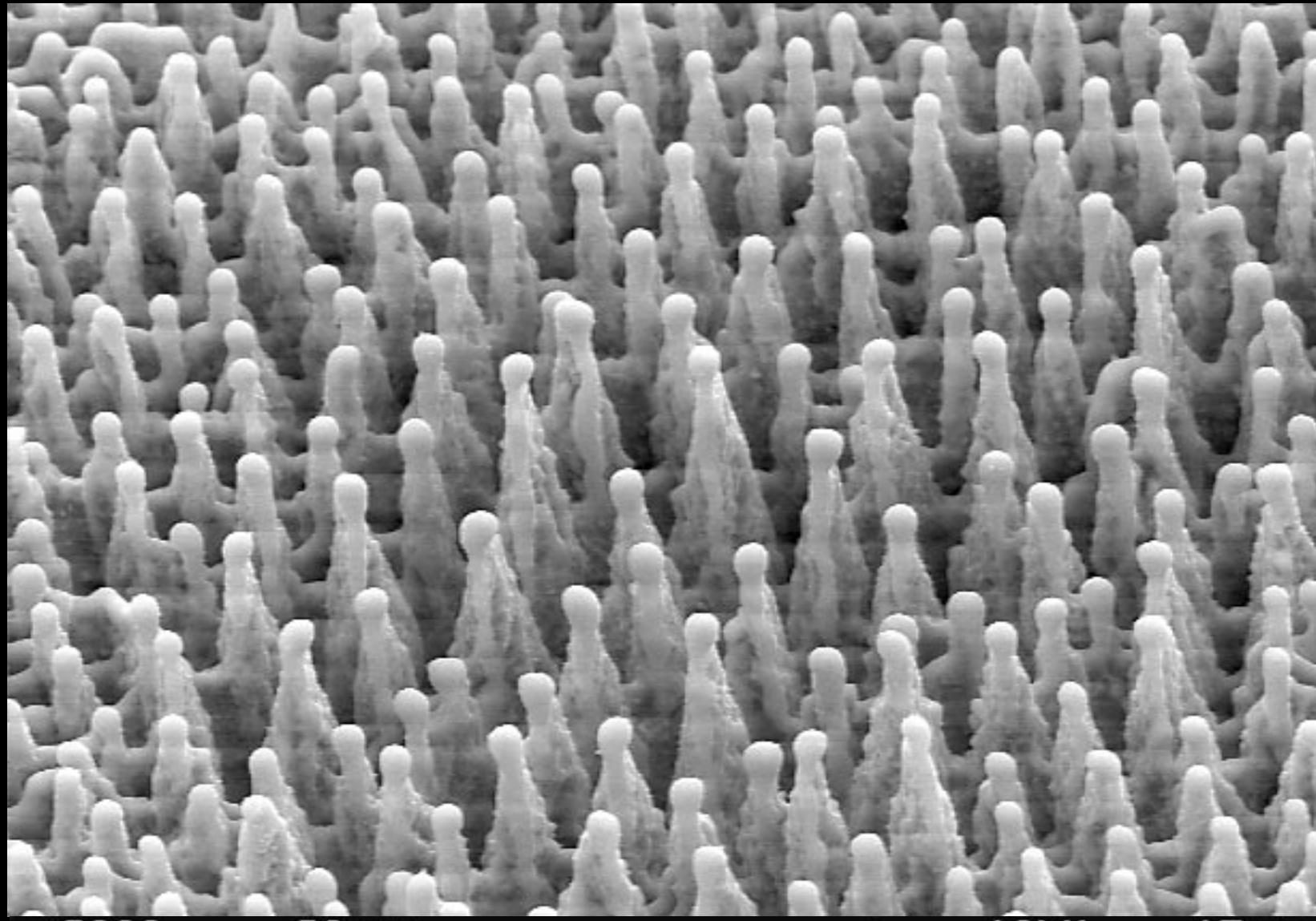
512 x 480

20 μm

10kV

15mm

0250



x2000

#3548

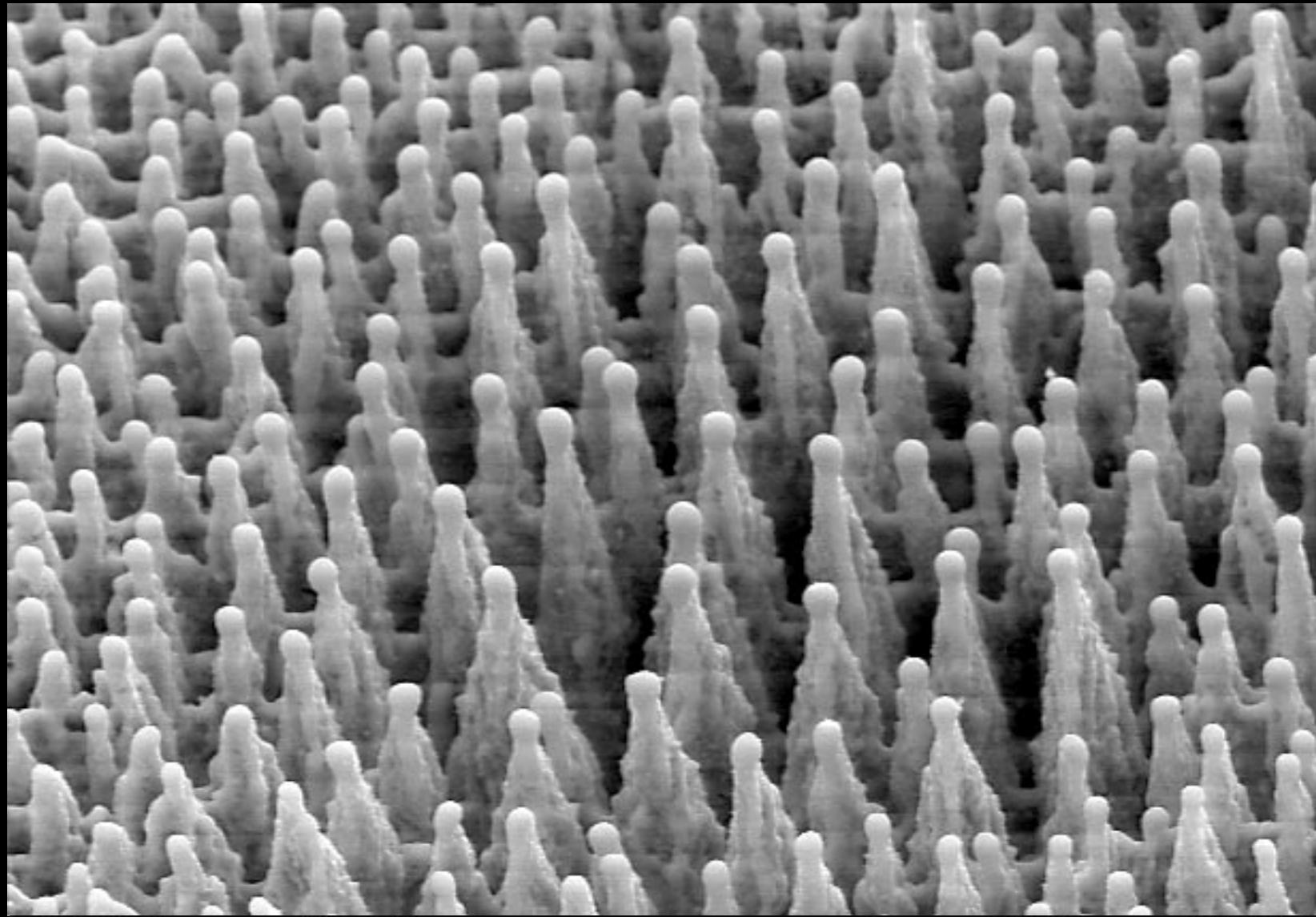
512 x 480

20  $\mu\text{m}$

10kV

15mm

0300



x2000

#3548

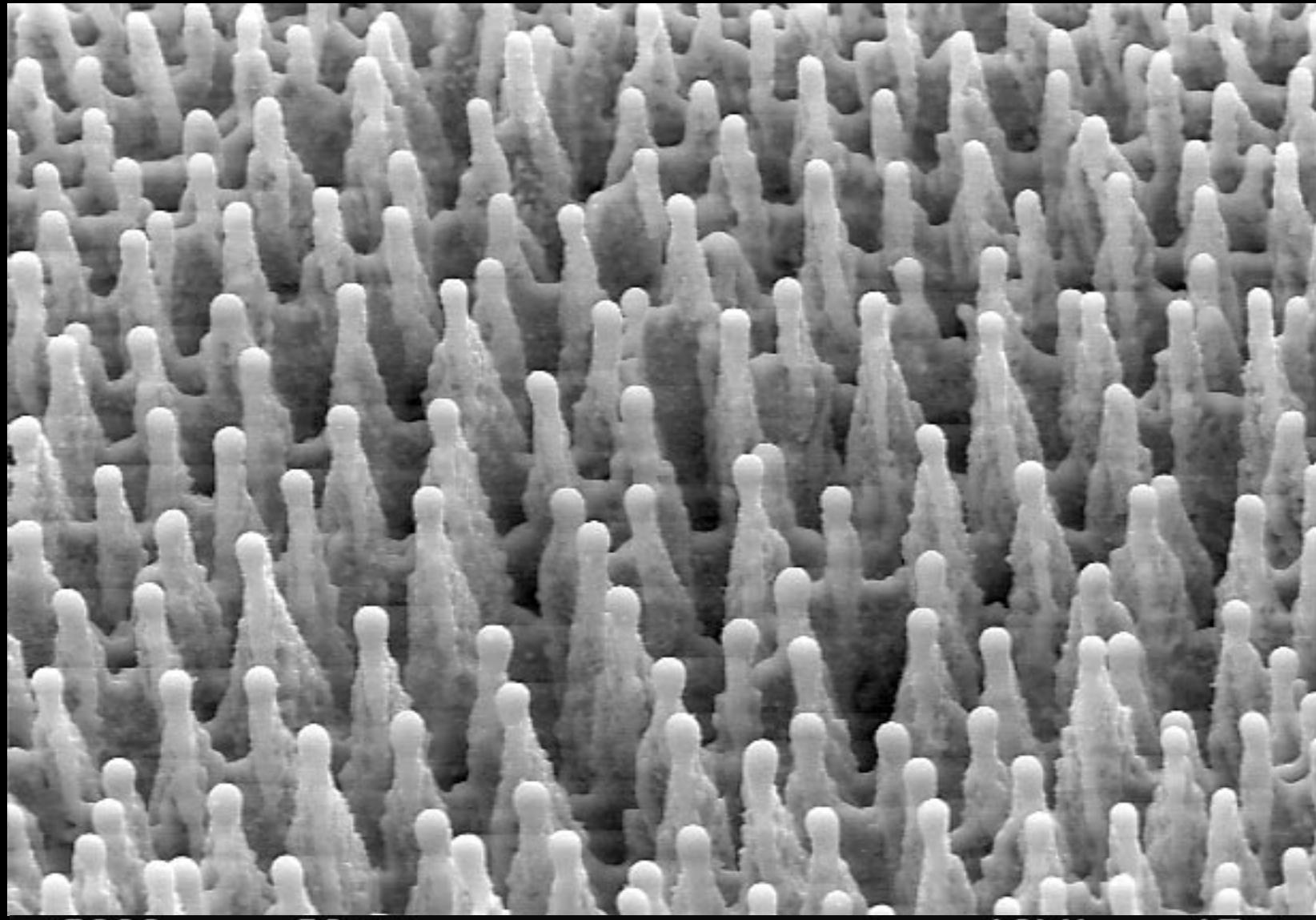
512 x 480

20  $\mu\text{m}$

10kV

15mm

0400



x2000

#3548

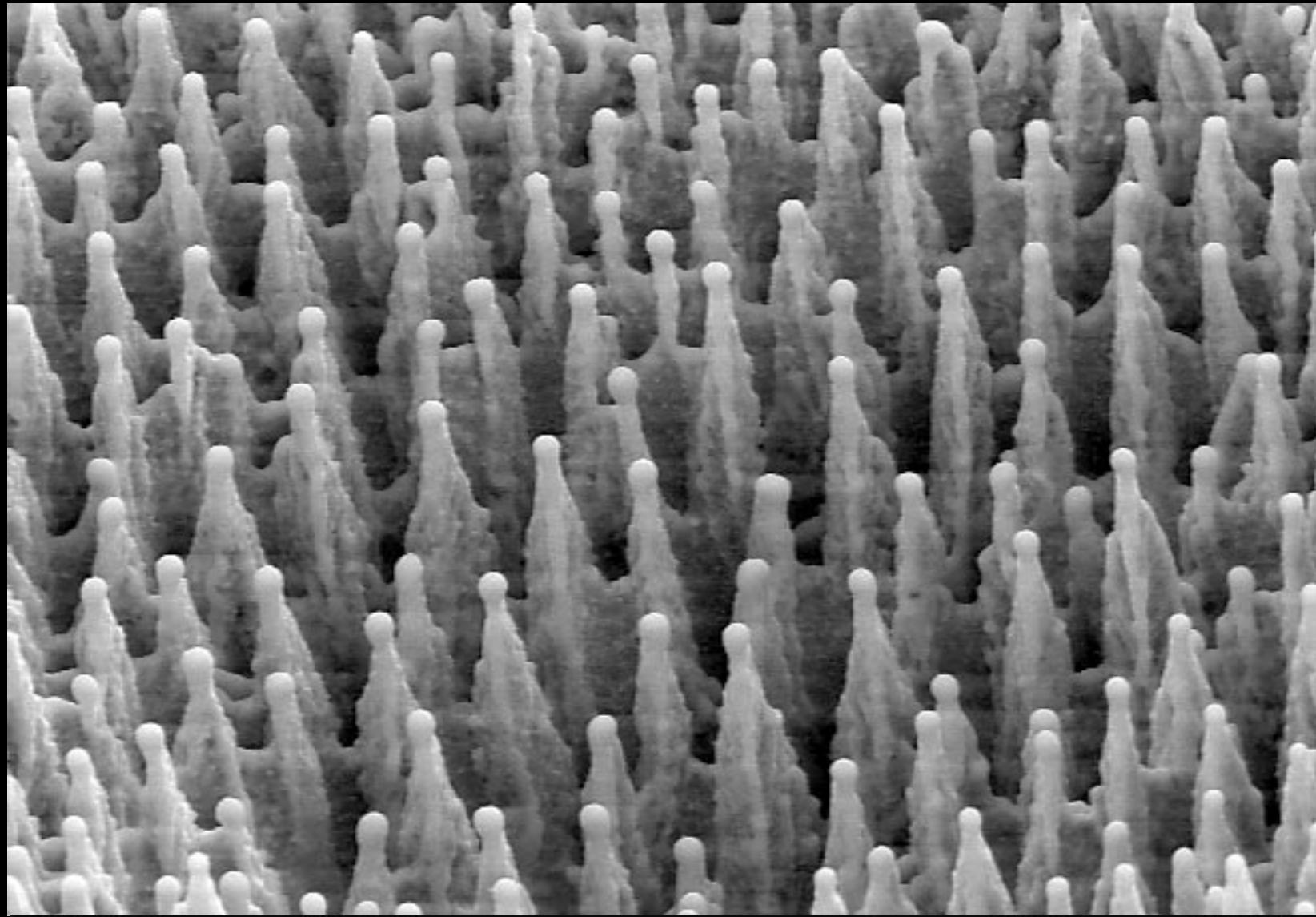
512 x 480

20  $\mu\text{m}$

10kV

15mm

0500



x2000

20  $\mu\text{m}$

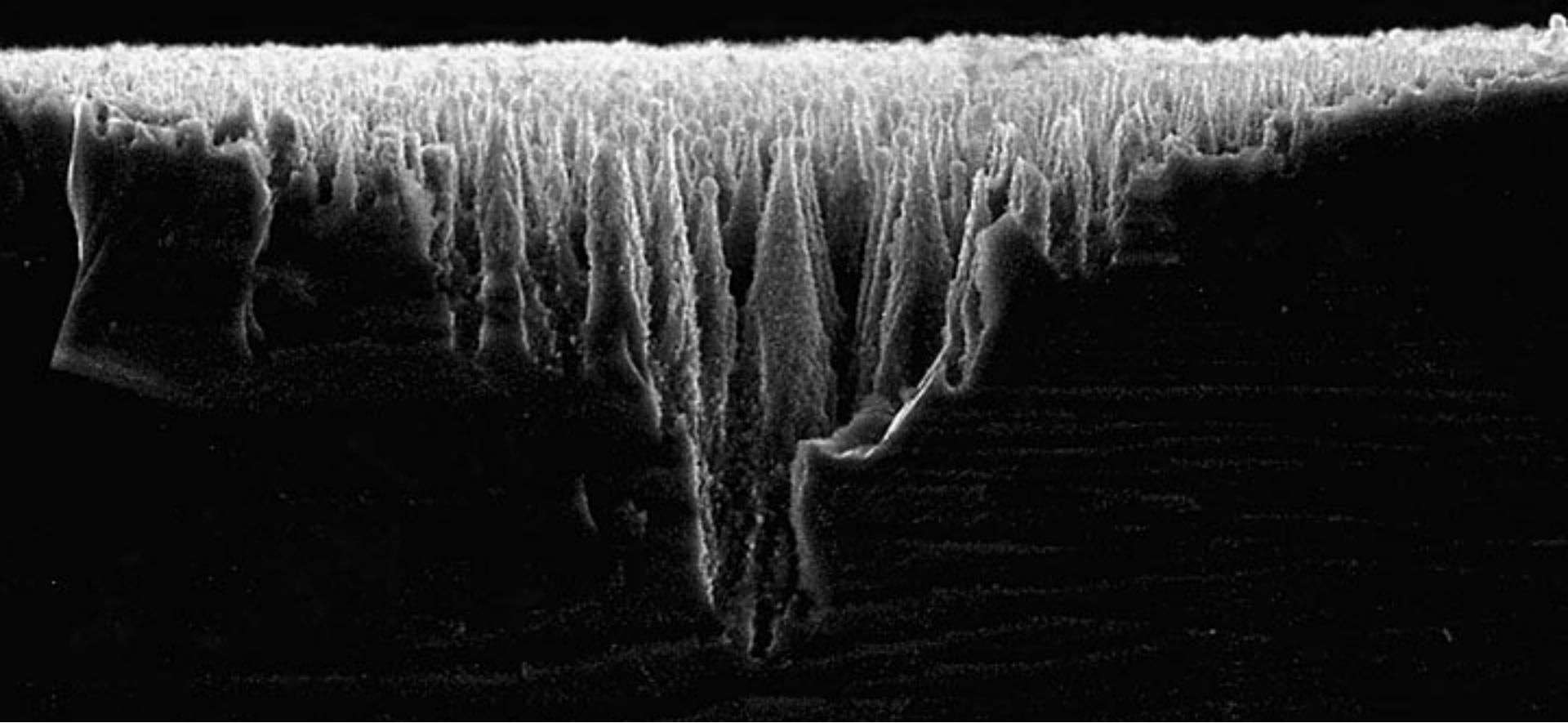
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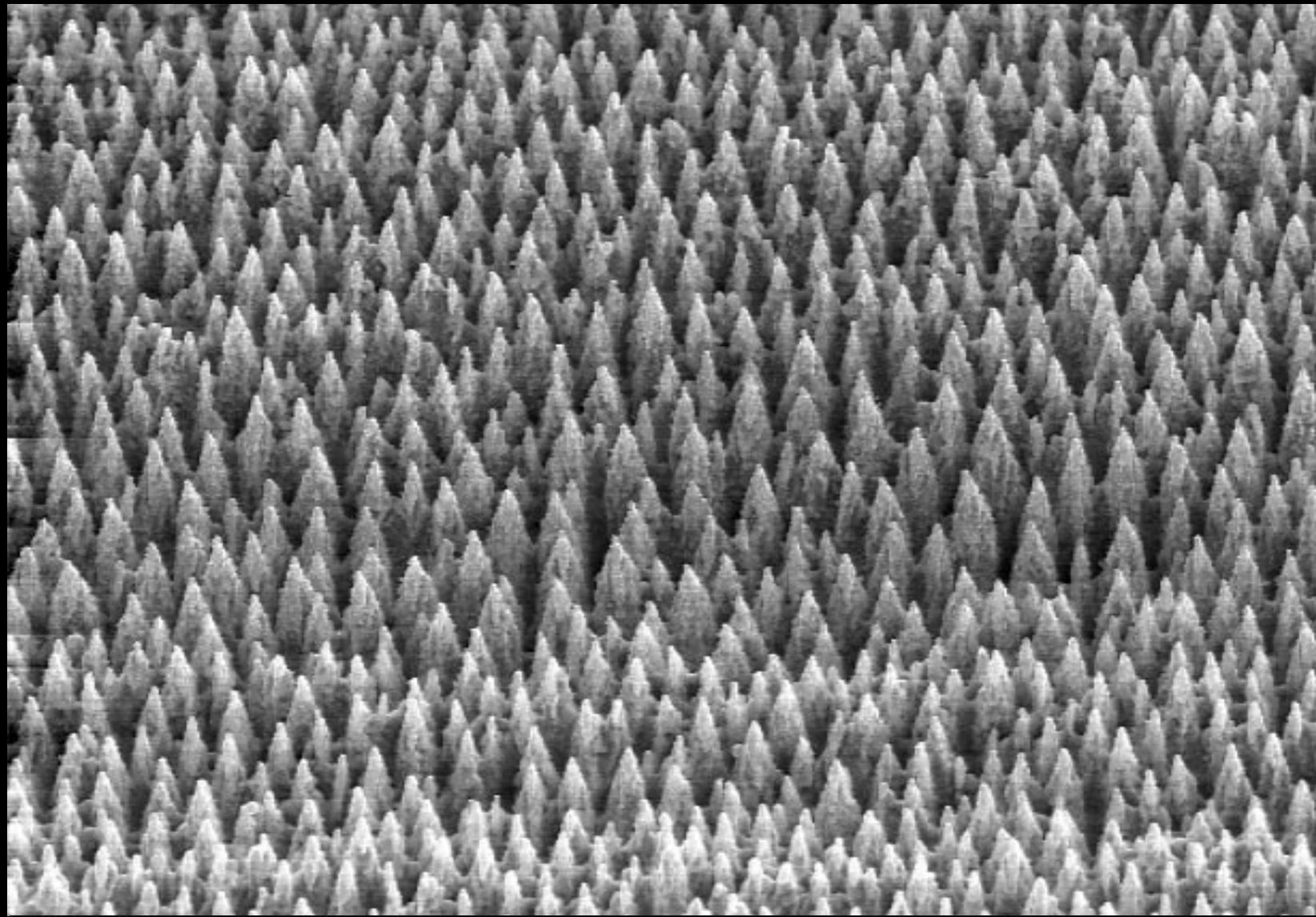
512 x 480

10kV

15mm

1000





x2000

#3548

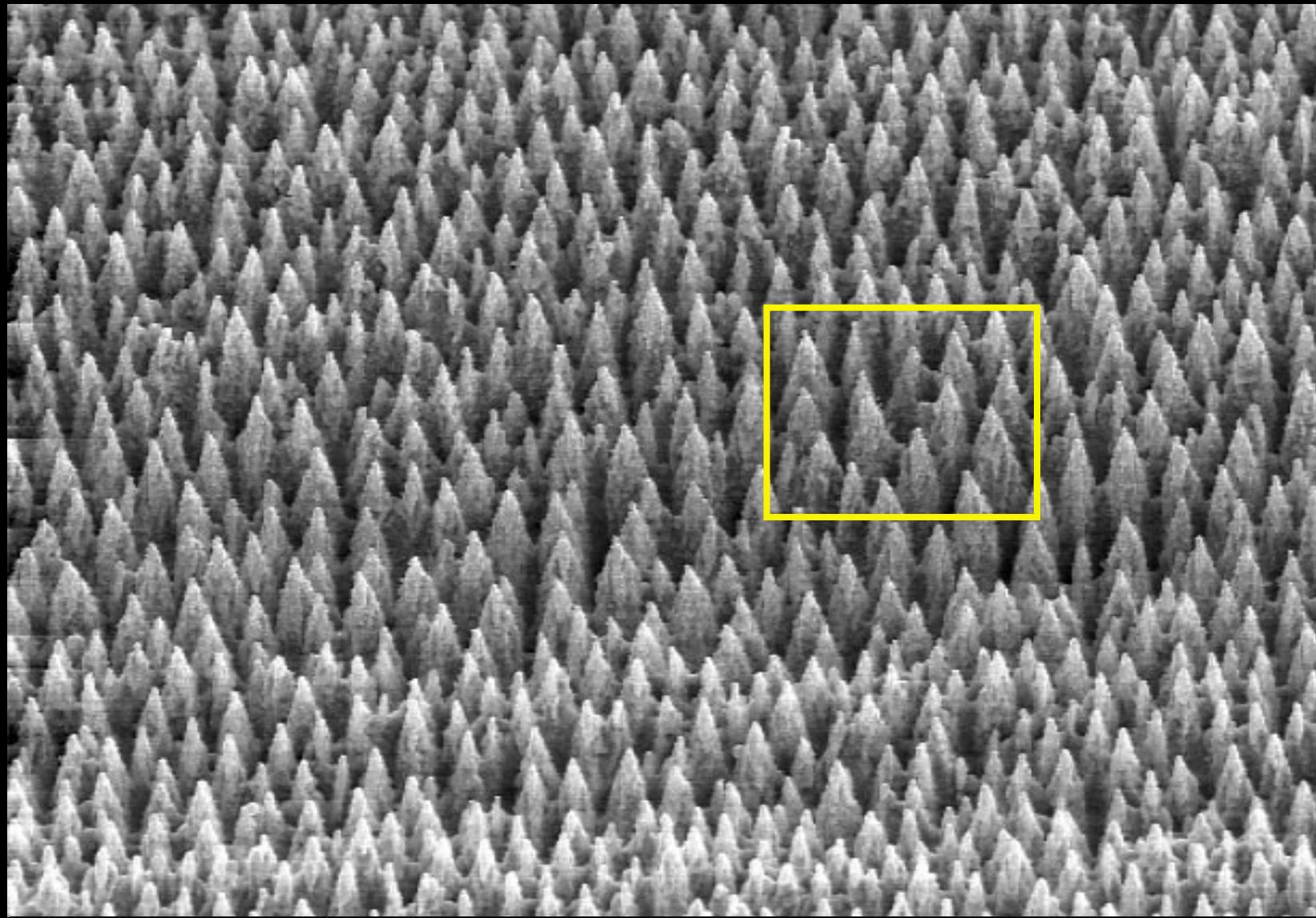
512 x 480

20 μm

10kV

15mm

scanned



x2000

#3548

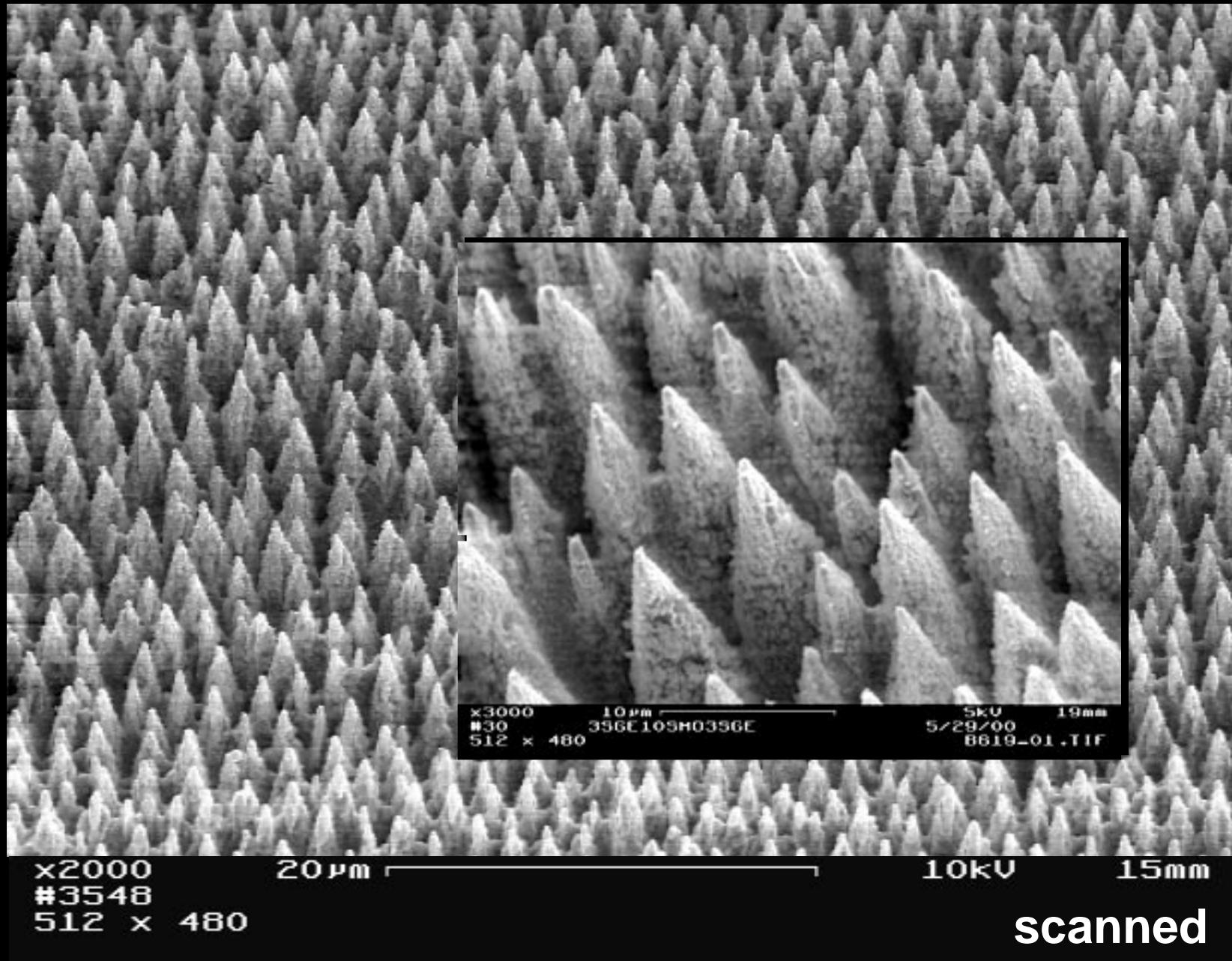
512 x 480

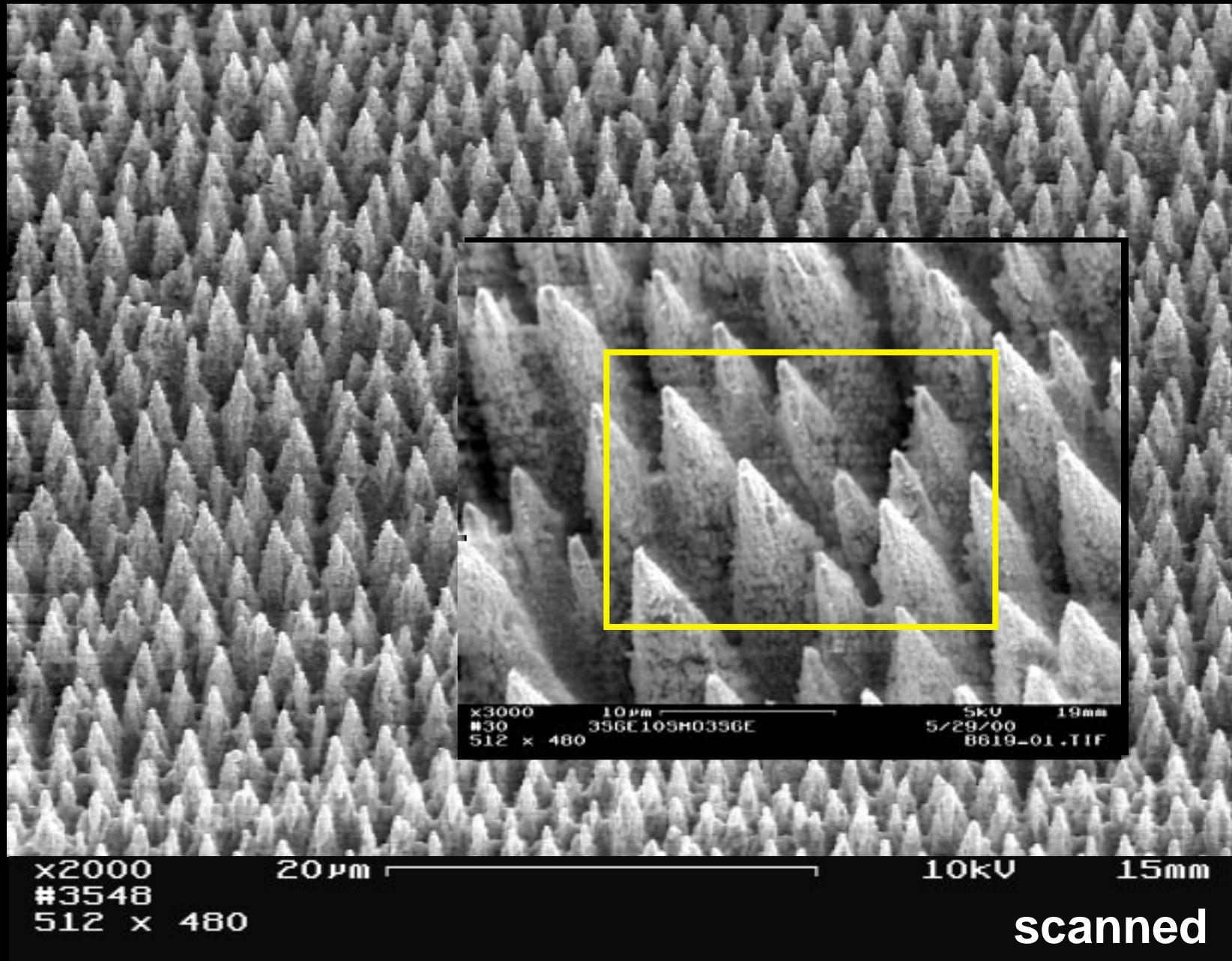
20 μm

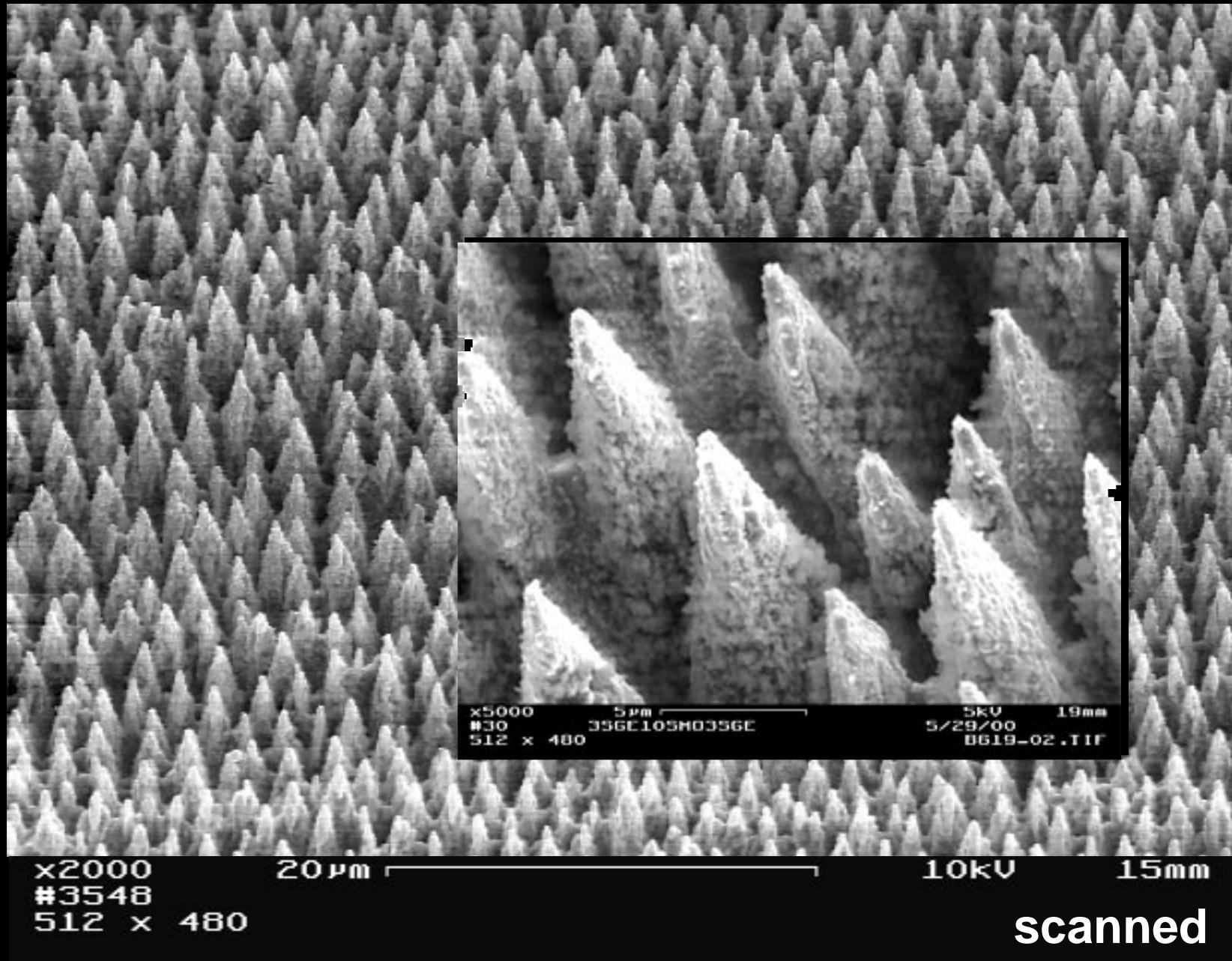
10kV

15mm

scanned

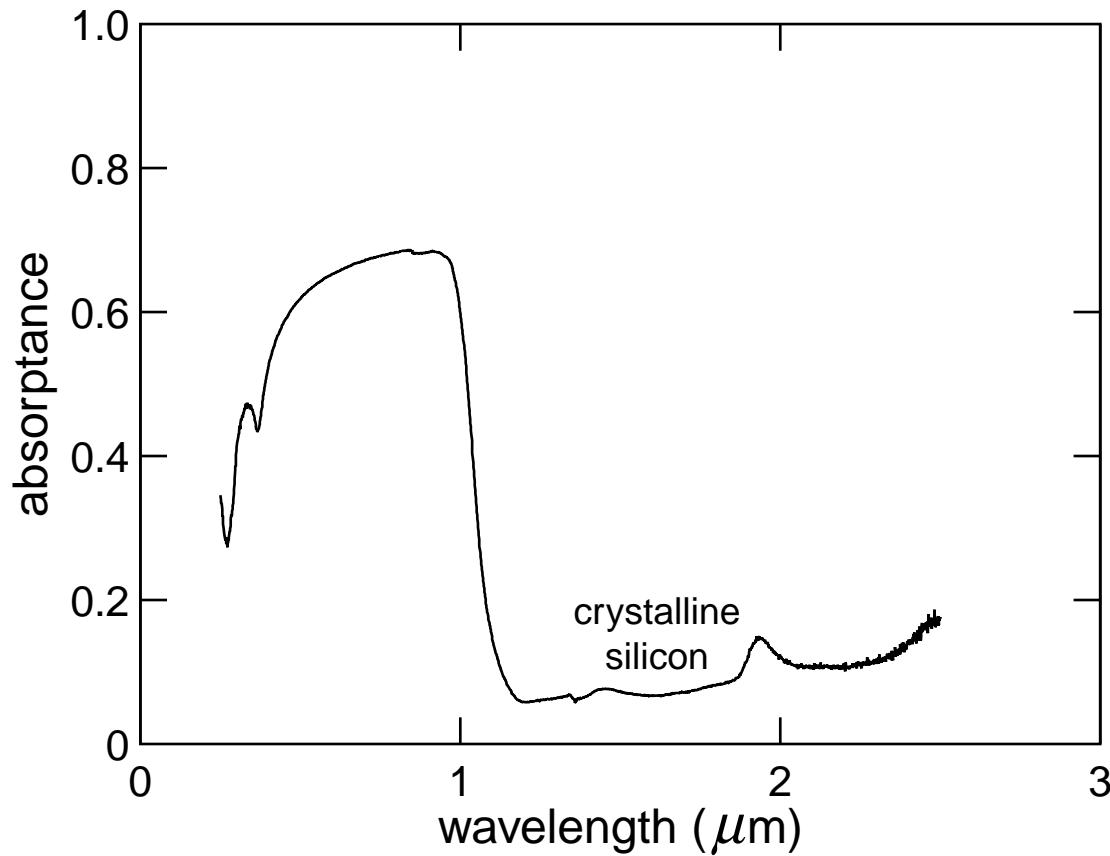






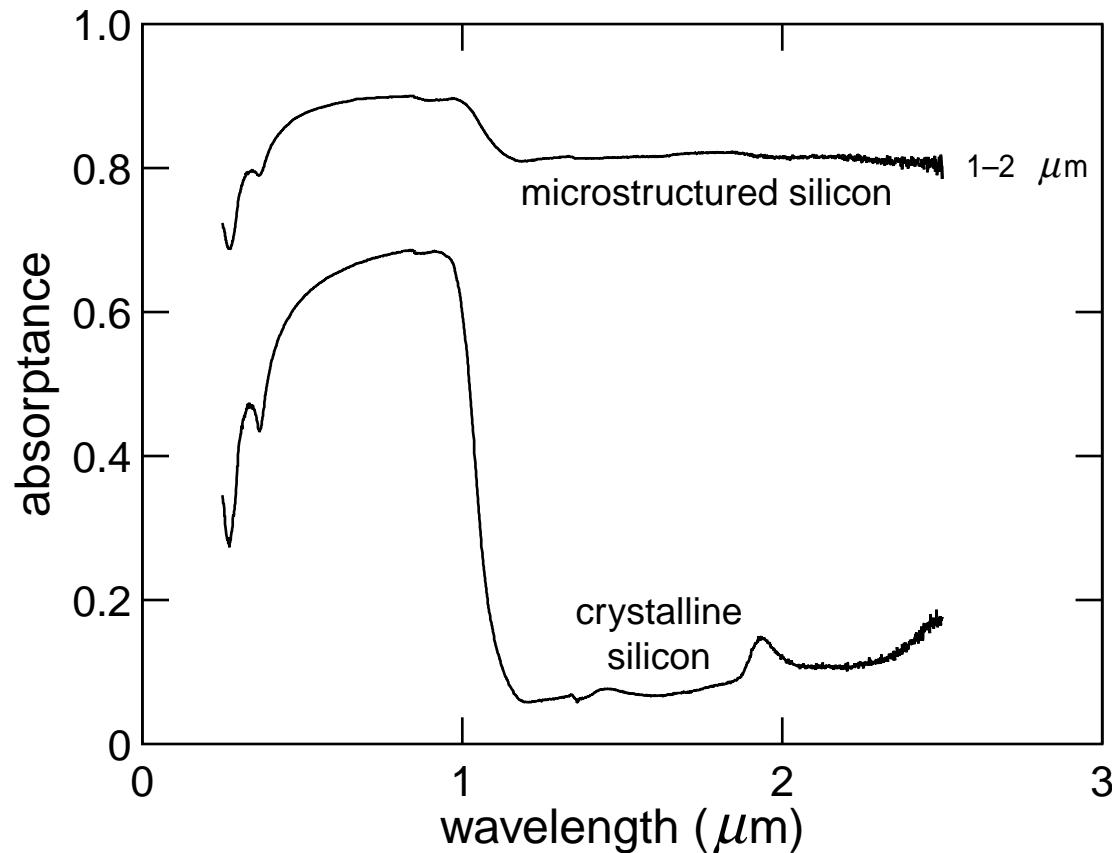
# *Background*

absorptance



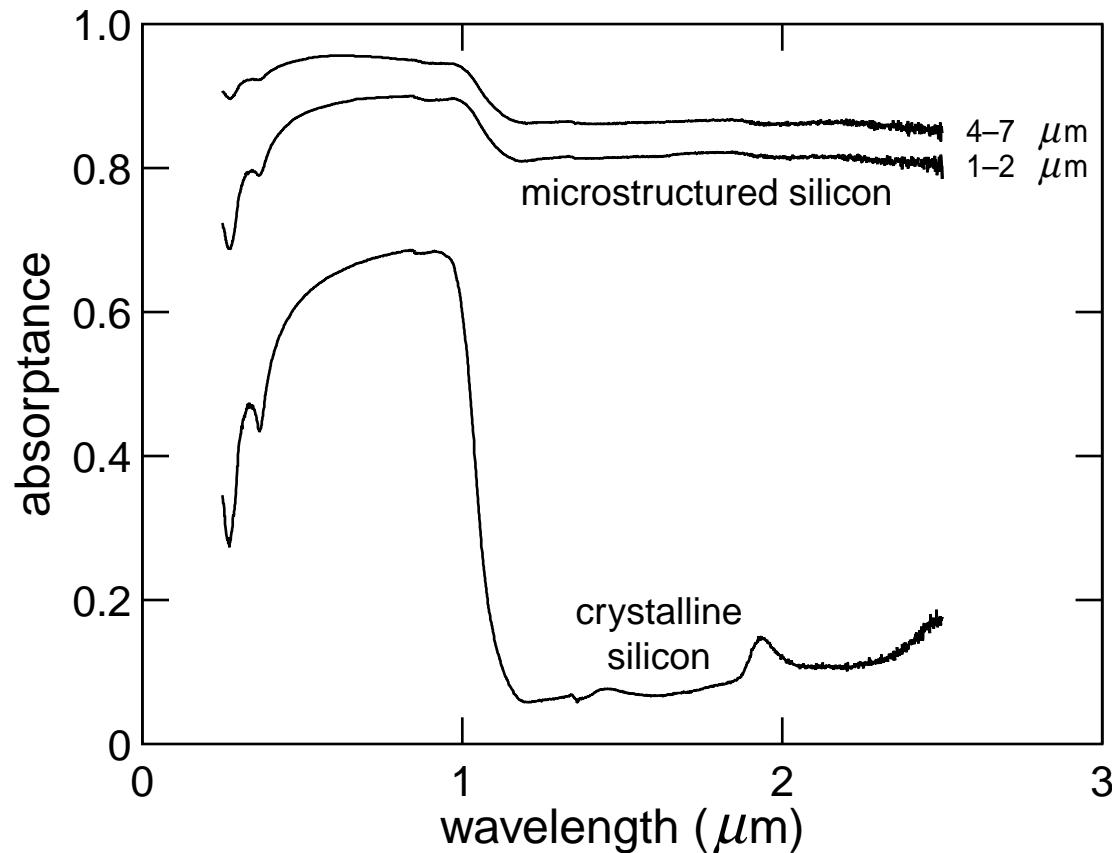
## *Background*

absorptance



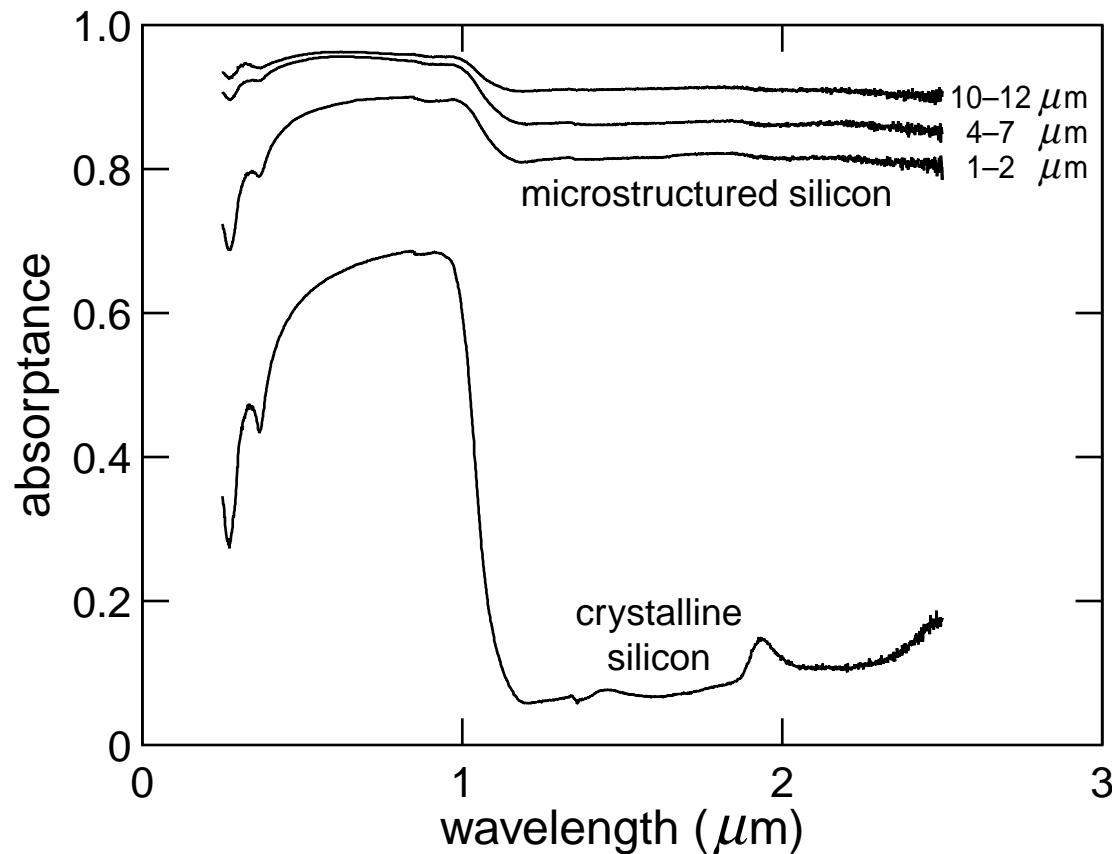
## *Background*

absorptance



## *Background*

absorptance



## *Background*

Points to keep in mind:

- ▶ one-step, maskless process
- ▶ large area with uniform high density of spikes
- ▶ band structure change

# *Outline*

- ▶ **Background**
- ▶ **Results**
- ▶ **Discussion**

# *Setup*



# *Setup*



gold coating

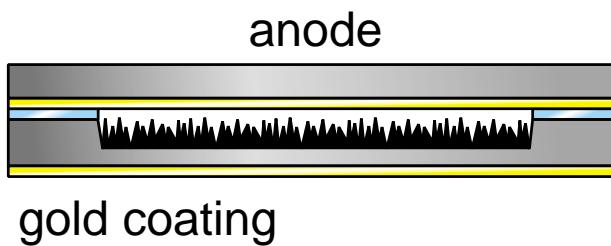
# *Setup*

20  $\mu\text{m}$  mica spacers

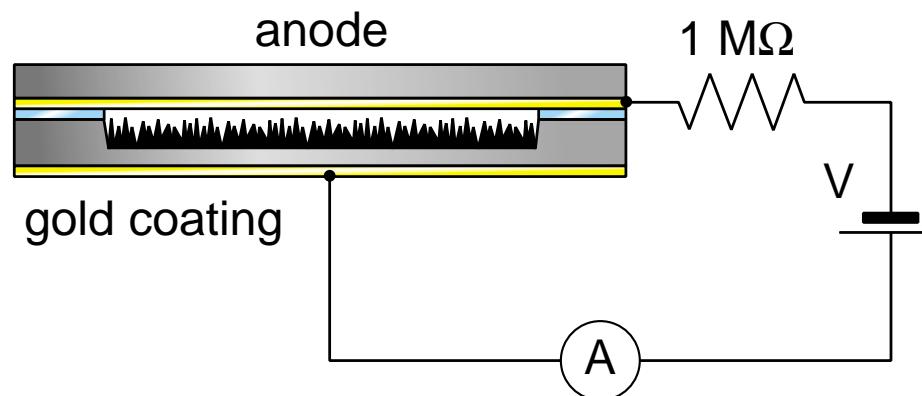


gold coating

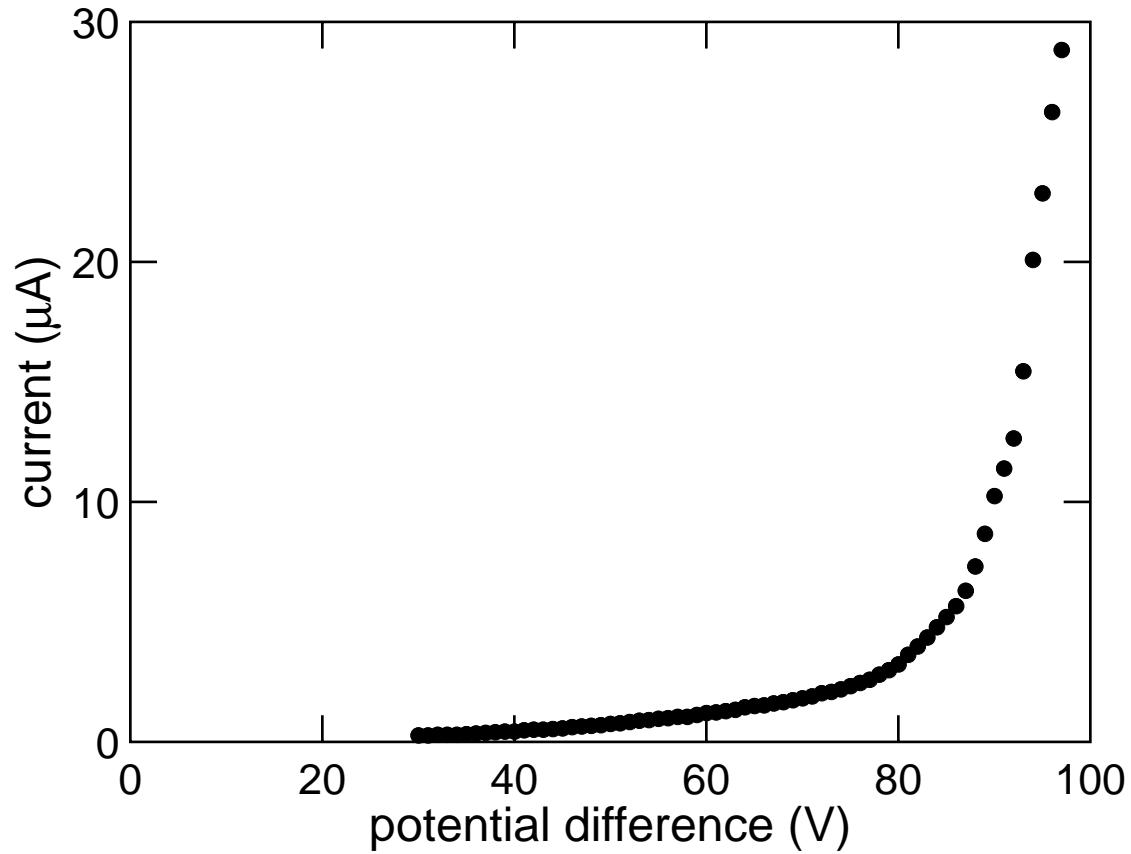
# *Setup*



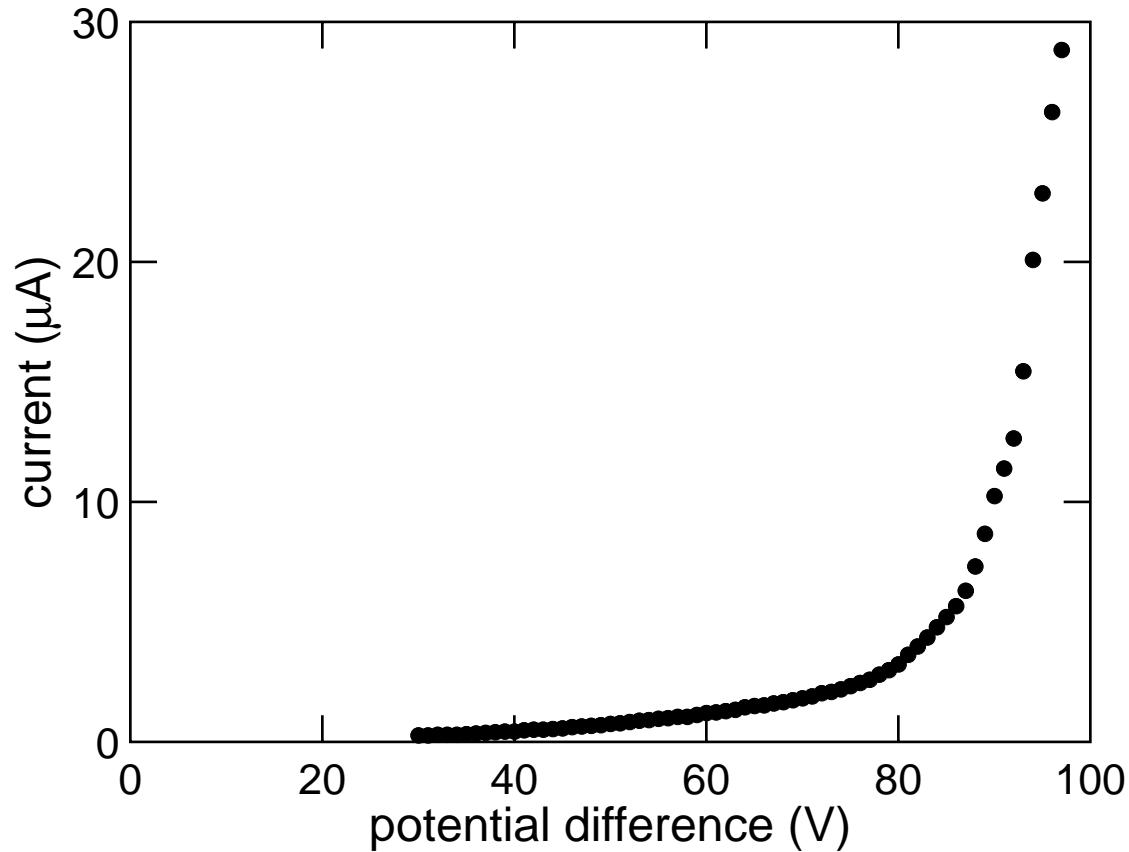
# *Setup*



# *Results*

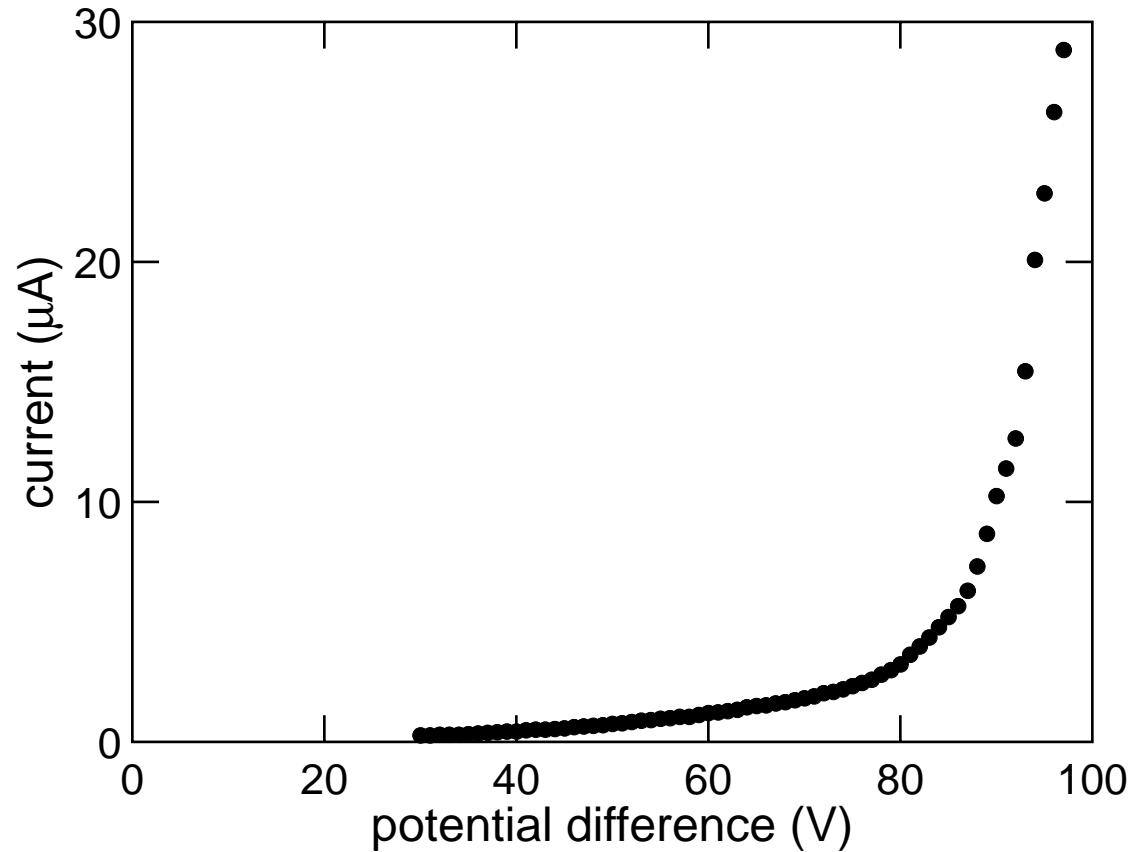


# *Results*



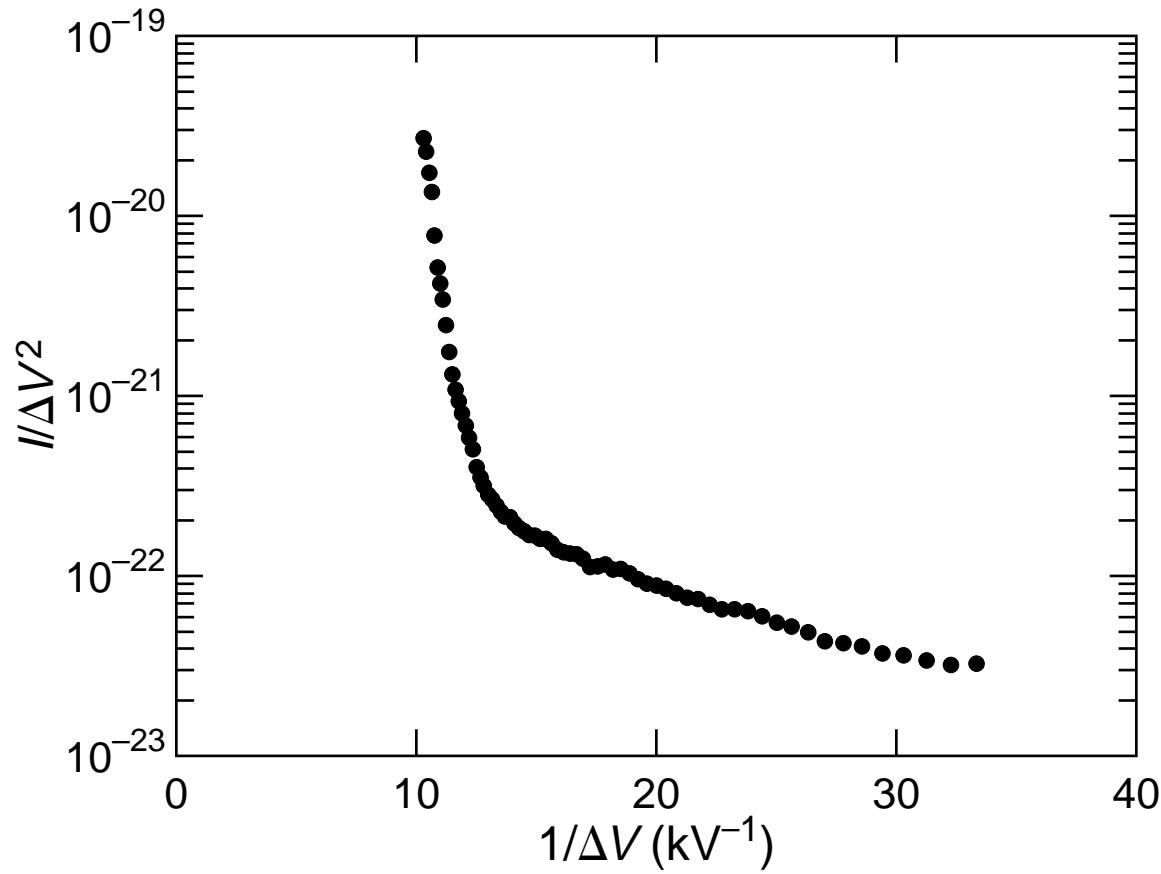
turn-on field ( $1 \mu\text{A}/\text{cm}^2$ ):  $1.2 \text{ V}/\mu\text{m}$

# *Results*

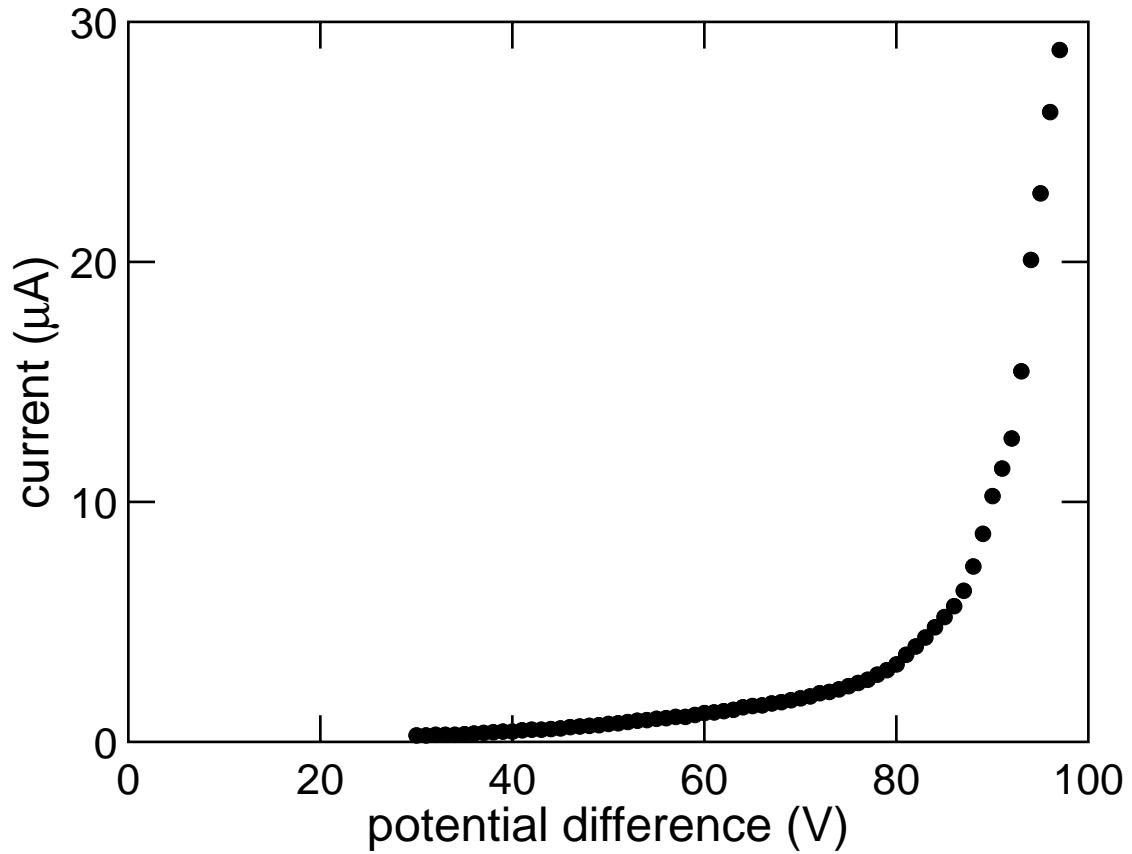


**threshold field ( $10 \mu\text{A}/\text{cm}^2$ ):  $2.1 \text{ V}/\mu\text{m}$**

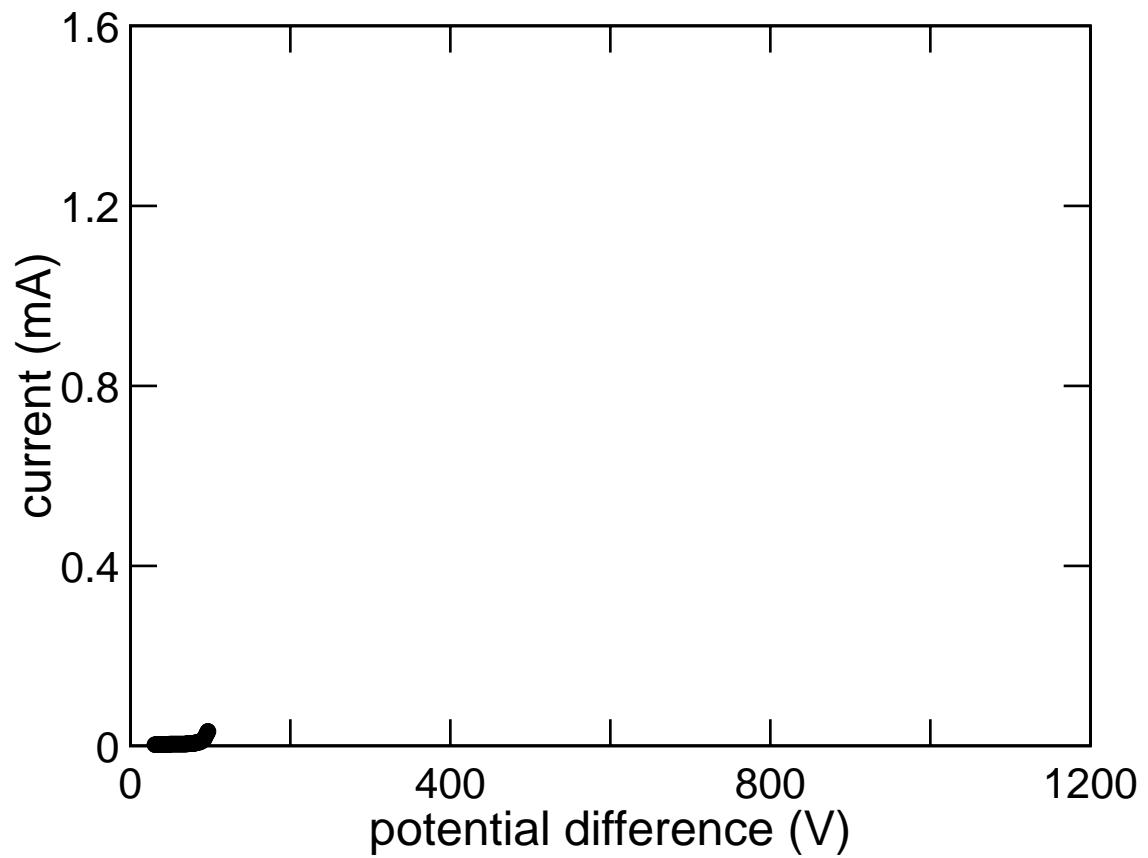
# *Results*



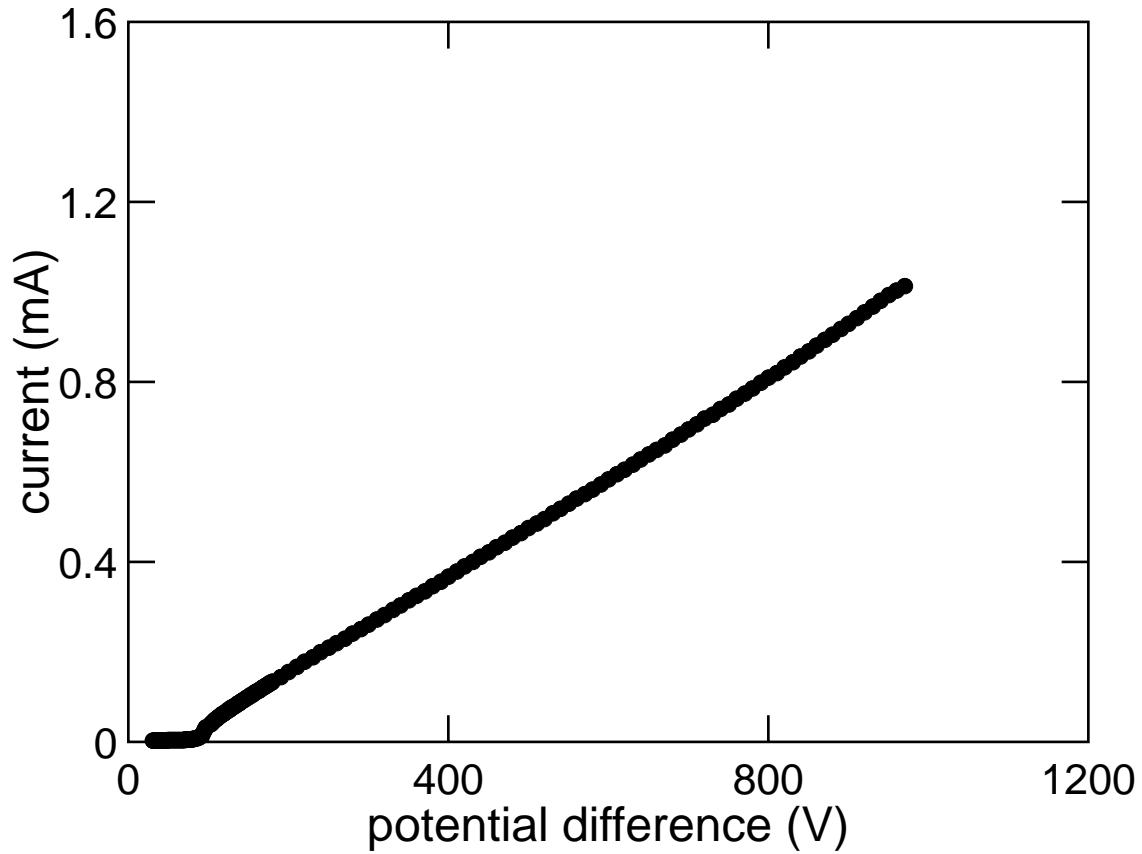
# *Results*



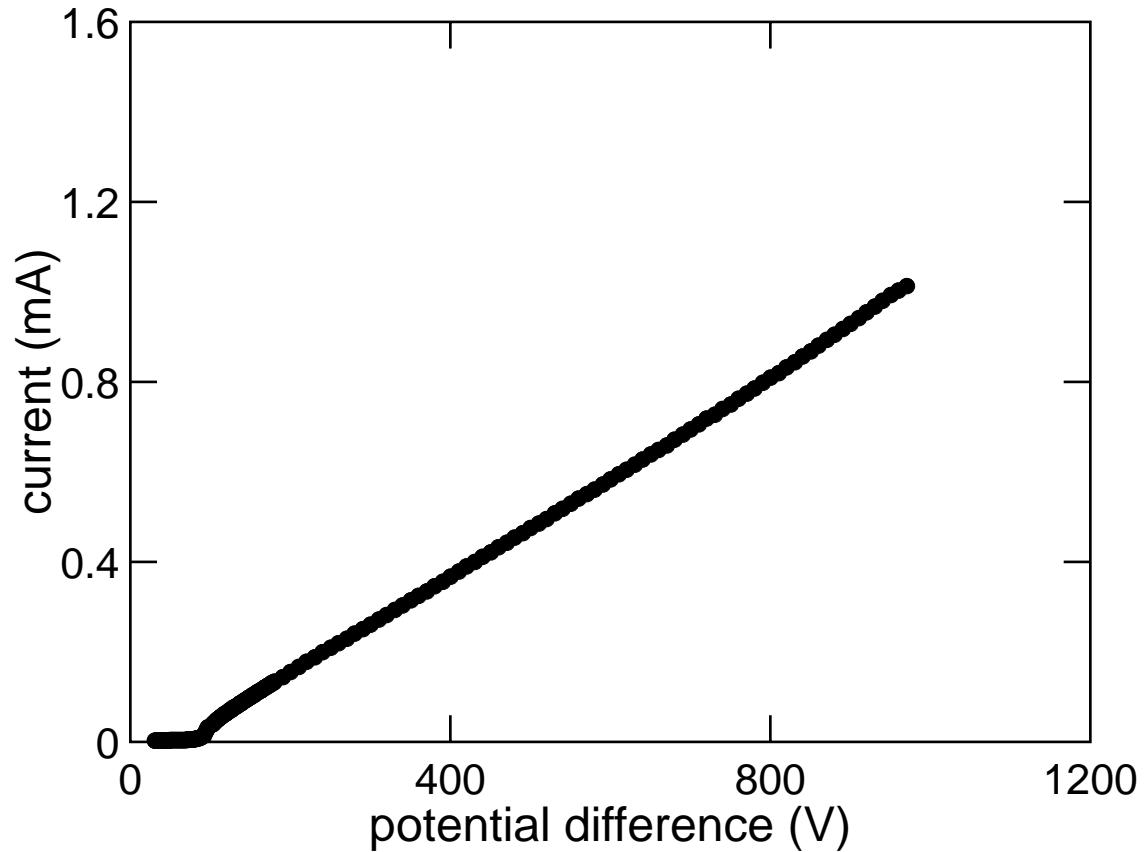
# *Results*



# *Results*

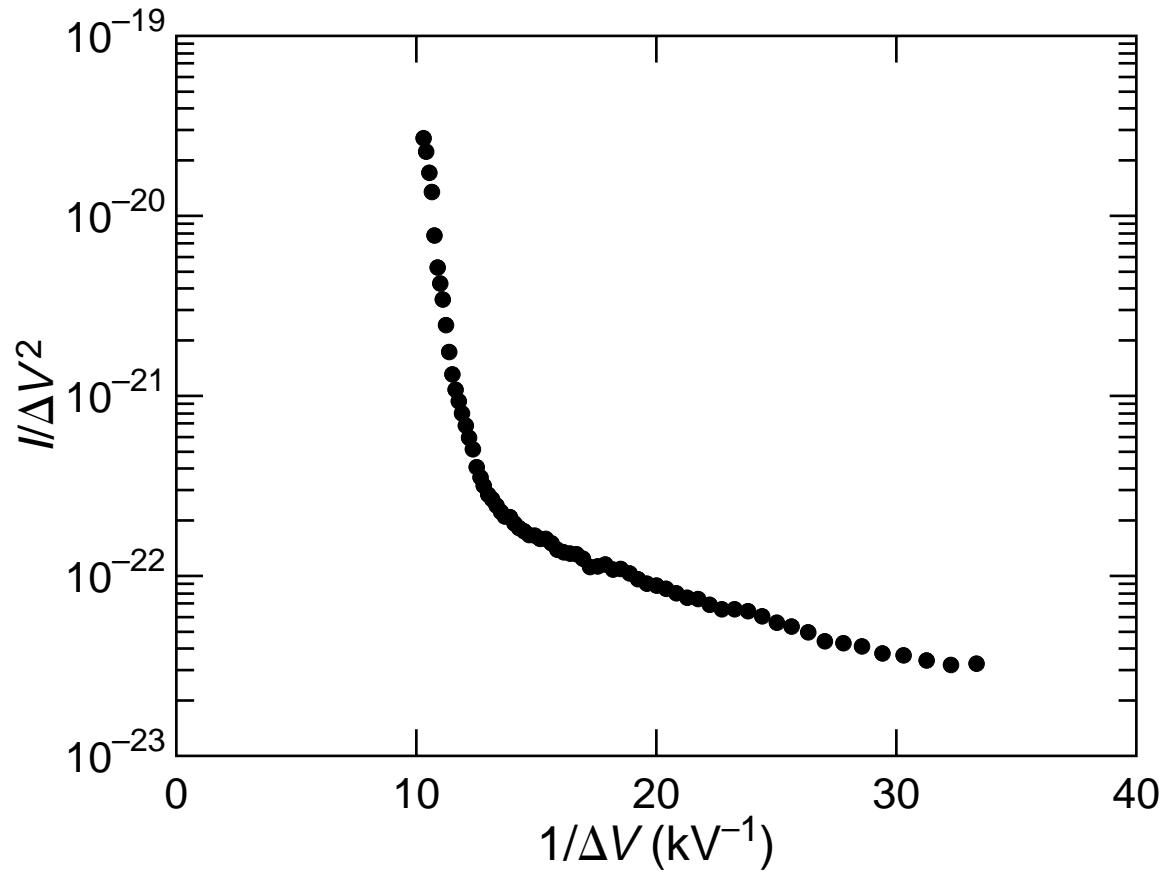


# *Results*

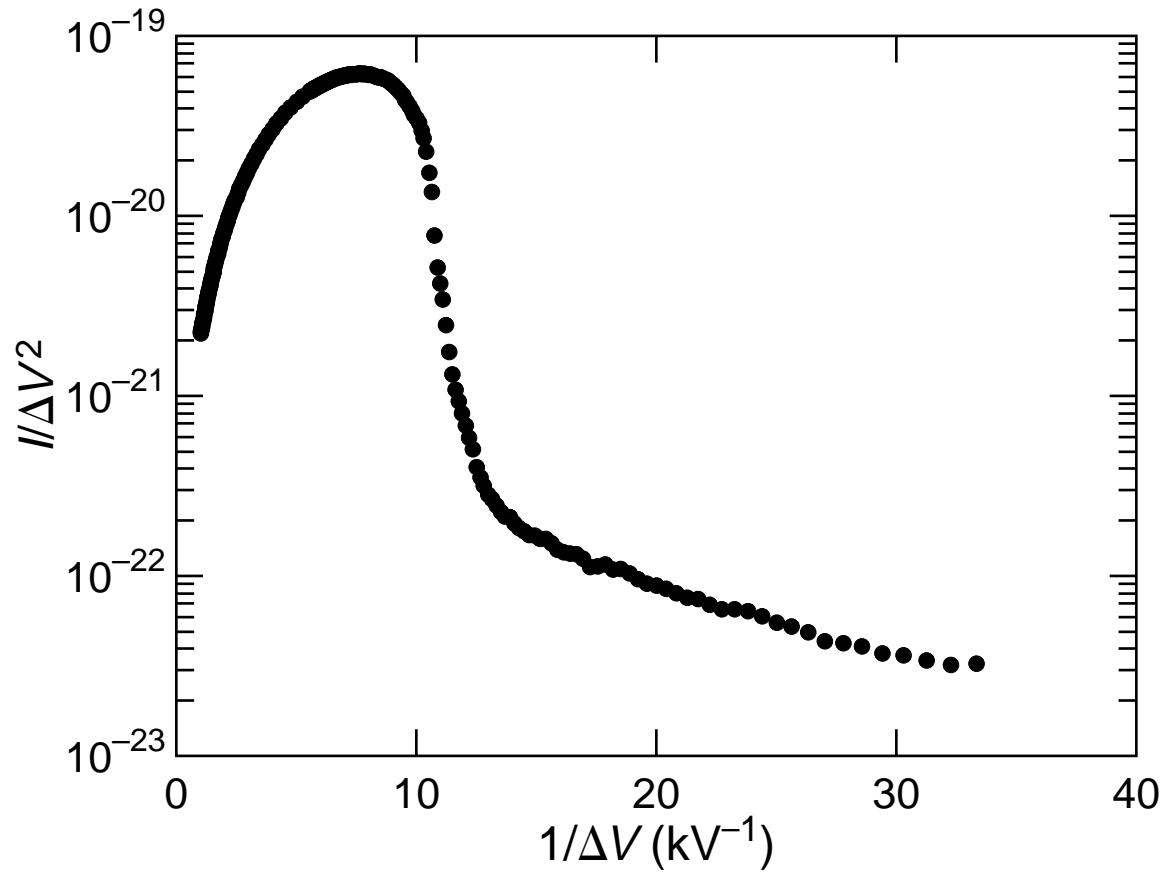


**maximum current: 15 mA (4 mm<sup>2</sup> sample)**

# *Results*



# *Results*



# *Outline*

- ▶ **Background**
- ▶ **Results**
- ▶ **Discussion**

## *Discussion*

### **Ion channeling and electron backscattering**

- ▶ **spikes retain crystalline order**
- ▶ **high density of defects**

## *Discussion*

Secondary ion mass spectrometry:

- ▶  $10^{20} \text{ cm}^{-3}$  sulfur
- ▶  $10^{17} \text{ cm}^{-3}$  fluorine

# *Discussion*

VB

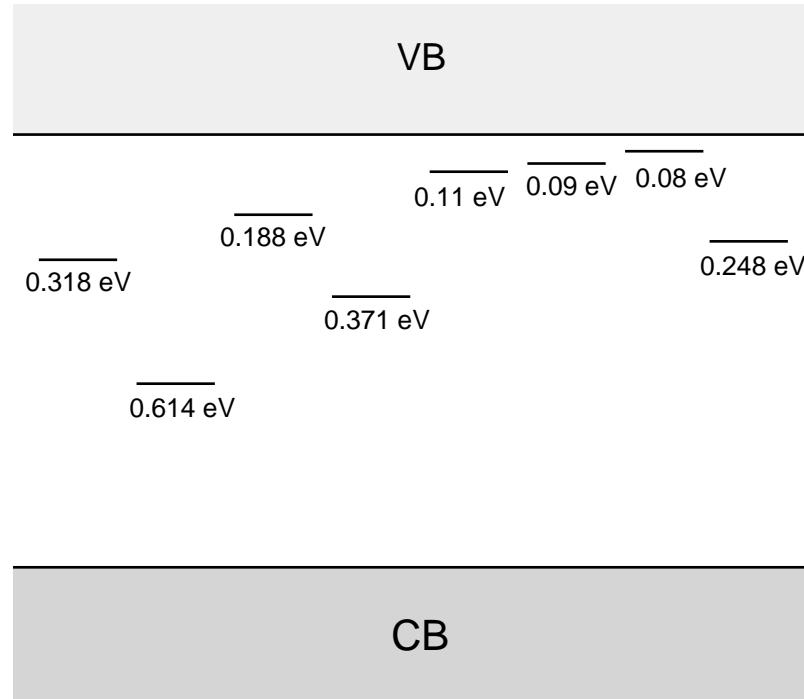
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CB

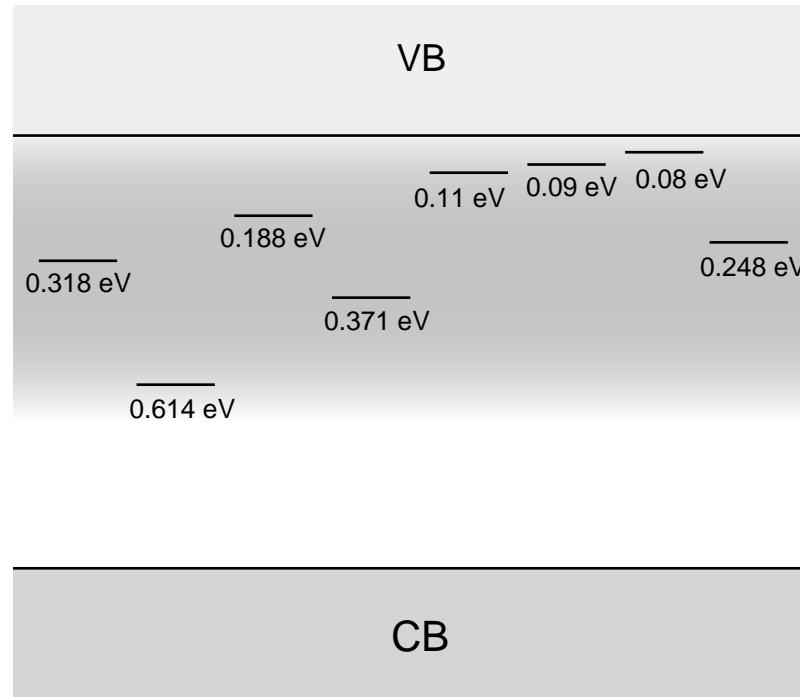
## *Discussion*

sulfur introduces states in the gap

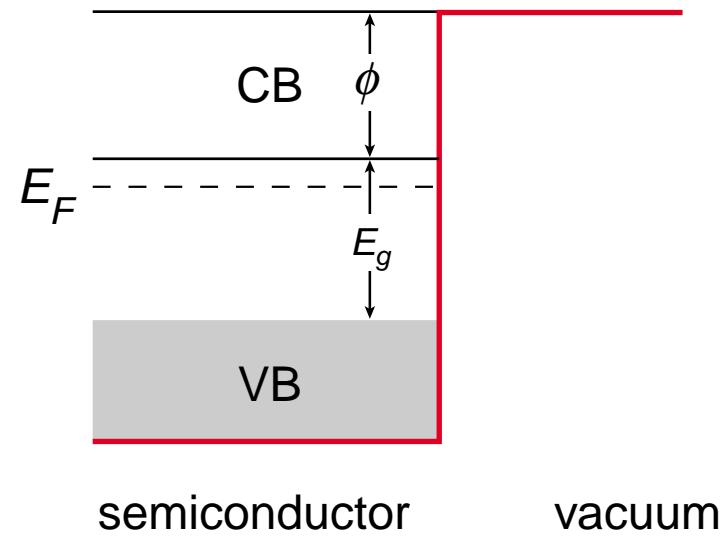


## *Discussion*

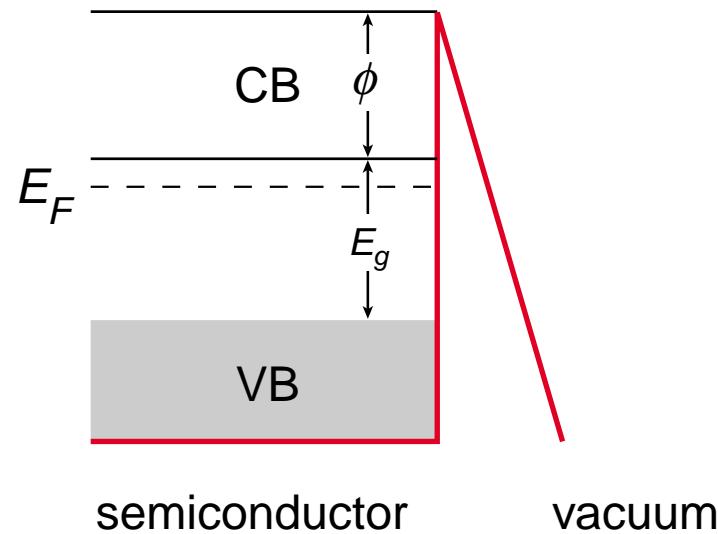
states broaden into a band



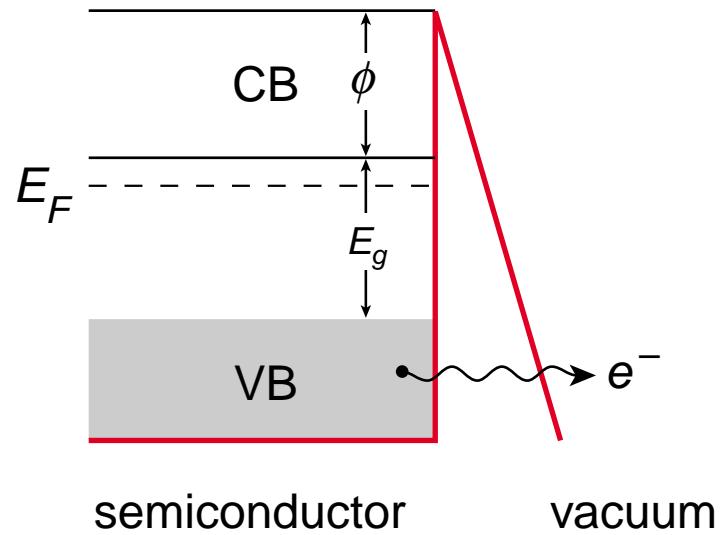
# *Field emission*



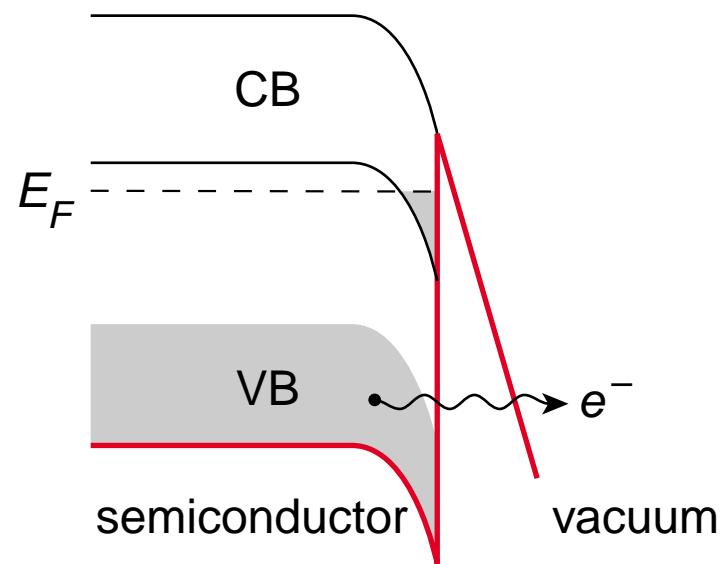
# *Field emission*



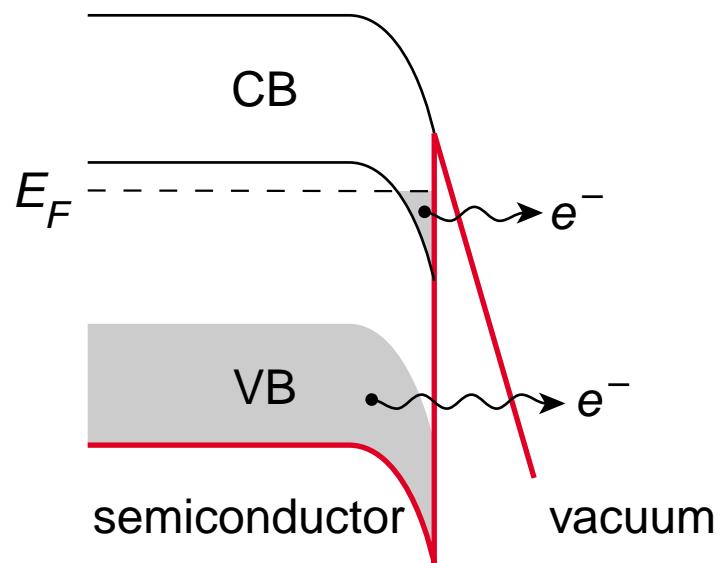
# Field emission



# *Field emission*

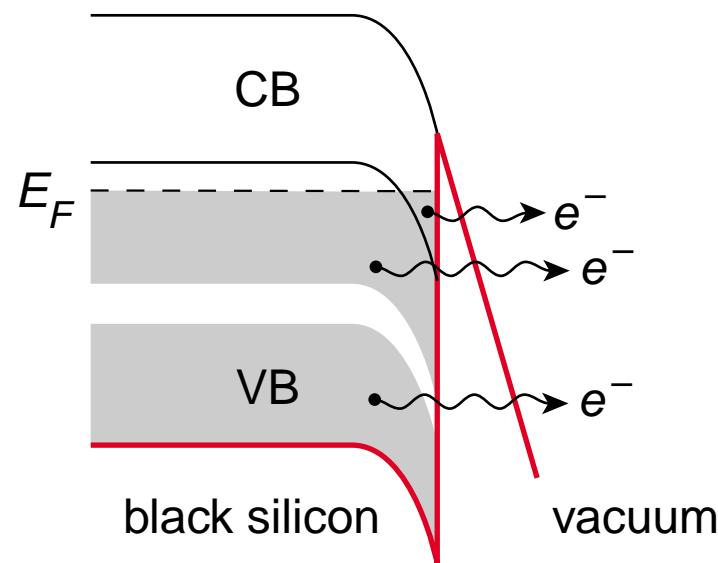


## *Discussion*



## *Discussion*

sulfur band provides additional electrons



## *Summary*

### **Microstructured silicon**

- ▶ fabricated by simple, maskless process

## *Summary*

### **Microstructured silicon**

- ▶ fabricated by simple, maskless process
- ▶ can be integrated with microelectronics

## *Summary*

### **Microstructured silicon**

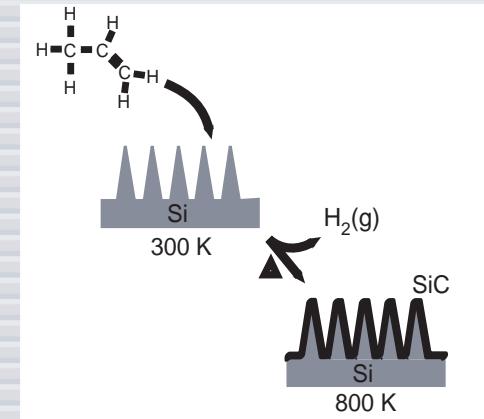
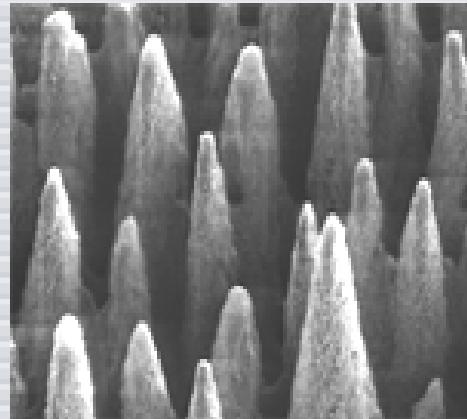
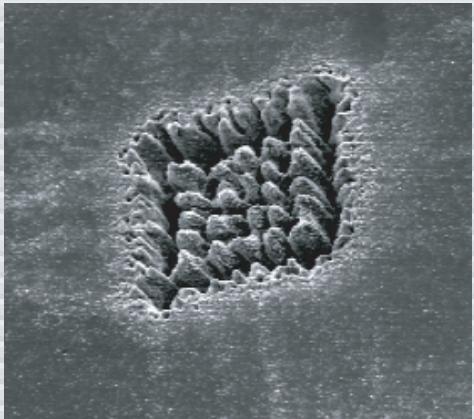
- ▶ fabricated by simple, maskless process
- ▶ can be integrated with microelectronics
- ▶ provides stable, high field-emission current

## *Summary*

### **Microstructured silicon**

- ▶ fabricated by simple, maskless process
- ▶ can be integrated with microelectronics
- ▶ provides stable, high field-emission current
- ▶ is durable

# *Future Directions*



- Ordered arrays
- Other gases
- Functionalizing
- Emission mechanism

## *Acknowledgements*

**Rebecca Younkin, Mike Sheehy, Catherine Crouch,  
Josh Levinson, and the Mazur group**

**Li Zhao, Fudan University, Shanghai, China**

**funding: ARO, NSF, NDSEG**

**<http://mazur-www.harvard.edu>**